



## SH1101A

### **132 X 64 Dot Matrix OLED/PLED Segment/Common Driver with Controller**

Preliminary

#### **Features**

- Support maximum 132 X 64 dot matrix panel
- Embedded 132 X 64 bits SRAM
- Operating voltage:
  - Logic voltage supply:  $V_{DD1} = 2.4V - 3.5V$
  - DC-DC voltage supply:  $V_{DD2} = 2.4V - 3.5V$
  - OLED Operating voltage supply:  $V_{PP} = 7.0V - 16.0V$
- Maximum segment output current: 320 $\mu$ A
- Maximum common sink current: 45mA
- 8-bit 6800-series parallel interface, 8-bit 8080-series parallel interface, serial peripheral interface
- Programmable frame frequency and multiplexing ratio
- Row re-mapping and column re-mapping (ADC)
- Vertical scrolling
- On-chip oscillator
- Available internal DC-DC converter
- 256-step contrast control on monochrome passive OLED panel
- Low power consumption
  - Sleep mode: <5 $\mu$ A
- Wide range of operating temperatures: -40 to +85°C
- Available in COG and TCP form

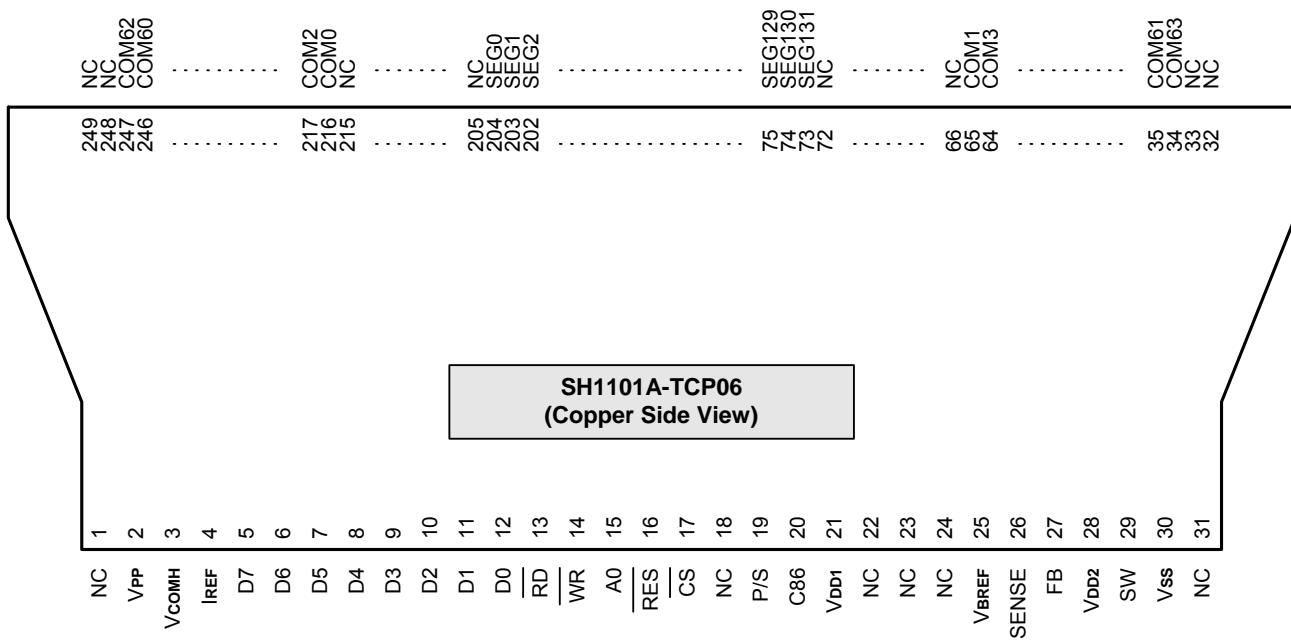
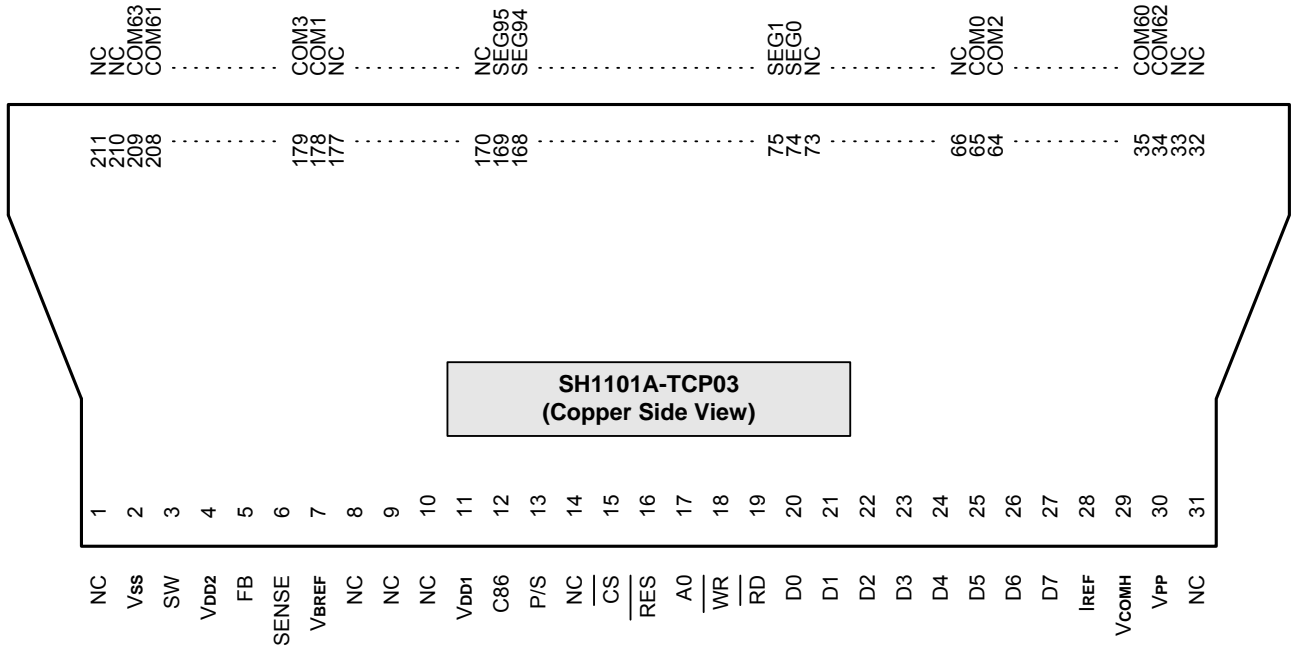
#### **General Description**

SH1101A is a single-chip CMOS OLED/PLED driver with controller for organic/polymer light emitting diode dot-matrix graphic display system. SH1101A consists of 132 segments, 64 commons that can support a maximum display resolution of 132 X 64. It is designed for Common Cathode type OLED panel.

SH1101A embeds with contrast control, display RAM oscillator and efficient DC-DC converter, which reduces the number of external components and power consumption. SH1101A is suitable for a wide range of compact portable applications, such as sub-display of mobile phone, calculator and MP3 player, etc.



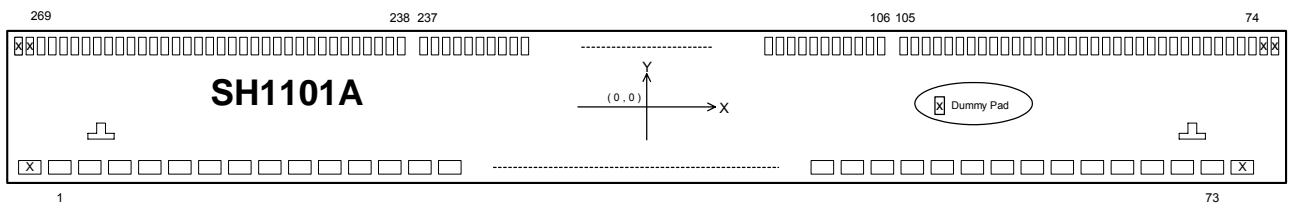
Pin Configuration





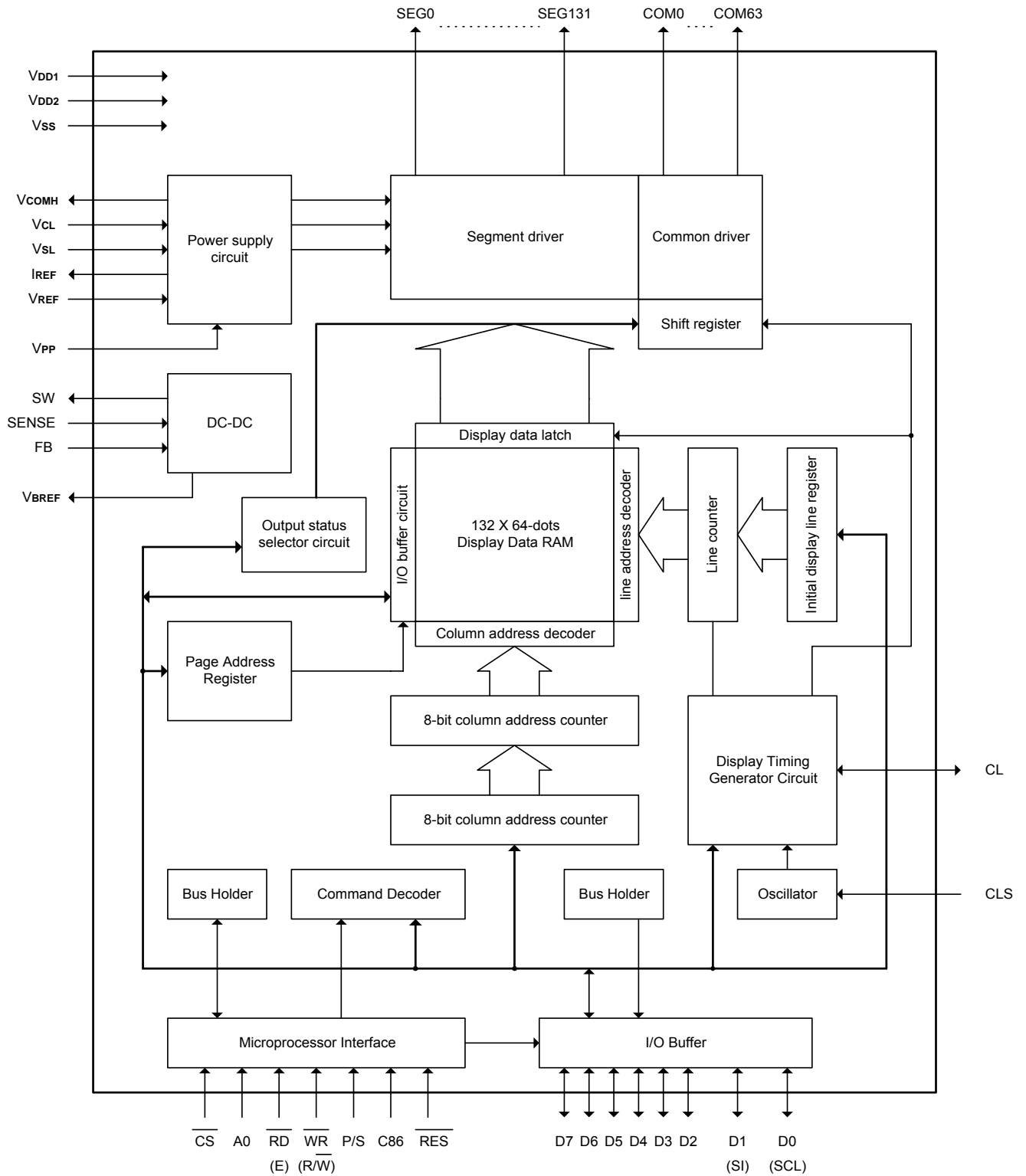
SH1101A

Pad Configuration





Block Diagram



**Pad Description****Power Supply**

Pad No.	Symbol	I/O	Description
28 - 31	VDD1	Supply	2.4 - 3.5V power supply input.
34, 44, 62	VDD1	Supply	2.4 - 3.5V power supply output for pad option.
17 - 20	VDD2	Supply	2.4 - 3.5V power supply pad for the internal buffer of the DC-DC voltage converter.
7 - 13	VSS	Supply	Ground.
21, 32, 36, 42, 64	VSS	Supply	Ground output for pad option.
49 - 53, 71 - 73	VPP	Supply	This is the most positive voltage supply pad of the chip. It should be supplied externally.
66	VPP	Supply	This is the most positive voltage output for pad option, which cannot be used as the most positive voltage input.
4 - 6	VSL	Supply	This is a segment voltage reference pad. This pad should be connected to VSS externally.
1 - 3	VCL	Supply	This is a common voltage reference pad. This pad should be connected to VSS externally.

**OLED Driver Supplies**

Pad No.	Symbol	I/O	Description
70	VREF	I	This is a voltage reference pad for pre-charge voltage in driving OLED device. Voltage should be set to match with the OLED driving voltage in current drive phase. It can either be supplied externally or by connecting to VPP.
65	IREF	O	This is a segment current reference pad. A resistor should be connected between this pad and VSS. Set the current at 10 $\mu$ A.
45 - 48, 67 - 69	VCOMH	O	This is a pad for the voltage output high level for common signals. A capacitor should be connected between this pad and VSS.
14 - 16	SW	O	This is an output pad driving the gate of the external NMOS of the booster circuit.
22	FB	I	This is a feedback resistor input pad for the booster circuit. It is used to adjust the booster output voltage level, VPP.
23	SENSE	I	This is a source current pad of the external NMOS of the booster circuit.
24	VBREF	O	This is an internal voltage reference pad for booster circuit. A stabilization capacitor, typical 1 $\mu$ F, should be connected to VSS.



**System Bus Connection Pads**

Pad No.	Symbol	I/O	Description												
37	CL	I/O	This pad is the system clock input. When internal clock is enabled, this pad should be Left open. The internal clock is output from this pad. When internal oscillator is disabled, this pad receives display clock signal from external clock source.												
63	CLS	I	This is the internal clock enable pad. CLS = "H": Internal oscillator circuit is enabled. CLS = "L": Internal oscillator circuit is disabled (requires external input). When CLS = "L", an external clock source must be connected to the CL pad for normal operation.												
33	C86	I	This is the MPU interface switch pad. C86 = "H": 8080 series MPU interface. C86 = "L": 6800 series MPU interface.												
35	P/S	I	This is the parallel data input/serial data input switch pad. P/S = "H": Parallel data input. P/S = "L": Serial data input. When P/S = "L", D2 to D7 are HZ. D2 to D7 may be "H", "L" or Open. $\overline{RD}$ (E) and $\overline{WR}$ (R/ $\overline{W}$ ) are fixed to either "H" or "L". With serial data input, RAM display data reading is not supported. These are MPU interface input selection pads. See the following table for selecting different interfaces: <table border="1" style="margin-left: 20px;"> <thead> <tr> <th></th> <th>6800-Parallel Interface</th> <th>8080-Parallel Interface</th> <th>Serial Interface</th> </tr> </thead> <tbody> <tr> <td>C86</td> <td>0</td> <td>1</td> <td>0</td> </tr> <tr> <td>P/S</td> <td>1</td> <td>1</td> <td>0</td> </tr> </tbody> </table>		6800-Parallel Interface	8080-Parallel Interface	Serial Interface	C86	0	1	0	P/S	1	1	0
	6800-Parallel Interface	8080-Parallel Interface	Serial Interface												
C86	0	1	0												
P/S	1	1	0												
38	$\overline{CS}$	I	This pad is the chip select input. When $\overline{CS}$ = "L", then the chip select becomes active, and data/command I/O is enabled.												
39	$\overline{RES}$	I	This is a reset signal input pad. When $\overline{RES}$ is set to "L", the settings are initialized. The reset operation is performed by the $\overline{RES}$ signal level.												
40	A0	I	This is the Data/Command control pad which determines whether the data bits are data or a command. A0 = "H": the inputs at D0 to D7 are treated as display data. A0 = "L": the inputs at D0 to D7 are transferred to the command registers.												
41	$\overline{WR}$ (R/ $\overline{W}$ )	I	This is a MPU interface input pad. When connected to an 8080 MPU, this is active LOW. This pad connects to the 8080 MPU $\overline{WR}$ signal. The signals on the data bus are latched at the rising edge of the $\overline{WR}$ signal. When connected to a 6800 Series MPU: This is the read/write control signal input terminal. When R/ $\overline{W}$ = "H": Read. When R/ $\overline{W}$ = "L": Write.												
43	$\overline{RD}$ (E)	I	This is a MPU interface input pad. When connected to an 8080 series MPU, it is active LOW. This pad is connected to the $\overline{RD}$ signal of the 8080 series MPU, and the SH1101A data bus is in an output status when this signal is "L". When connected to a 6800 series MPU, this is active HIGH. This is used as an enable clock input of the 6800 series MPU.												
54 - 61	D0 - D7	I/O	This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-bit standard MPU data bus. When the serial interface is selected, then D0 serves as the serial clock input pad (SCL) and D1 serves as the serial data input pad (SI). At this time, D2 to D7 are set to high impedance. When the chip select is inactive, D0 to D7 are set to high impedance.												
54	(SCL)	I													
55	(SI)	I													



**OLED Drive Pads**

<b>Pad No.</b>	<b>Symbol</b>	<b>I/O</b>	<b>Description</b>
105 - 74, 238 - 269	COM0 - 63	O	These pads are Common signal output for OLED display.
106 - 237	SEG0 - 131	O	These pads are Segment signal output for OLED display.

**Test Pads**

<b>Pad No.</b>	<b>Symbol</b>	<b>I/O</b>	<b>Description</b>
25	TEST1	I	Test pads, internal pull low, no connection for user.
27	TEST2	O	Test pads, no connection for user.
26	TEST3	I	Test pads, no connection for user.
-	NC	-	NC pads, no connection for user.



**Functional Description**

**Microprocessor Interface Selection**

The 8080-Parallel Interface, 6800-Parallel Interface or Serial Interface (SPI) can be selected by different selections of C86, P/S as shown in Table 1.

**Table. 1**

	6800-Parallel Interface	8080-Parallel Interface	Serial Interface
C86	0	1	0
P/S	1	1	0

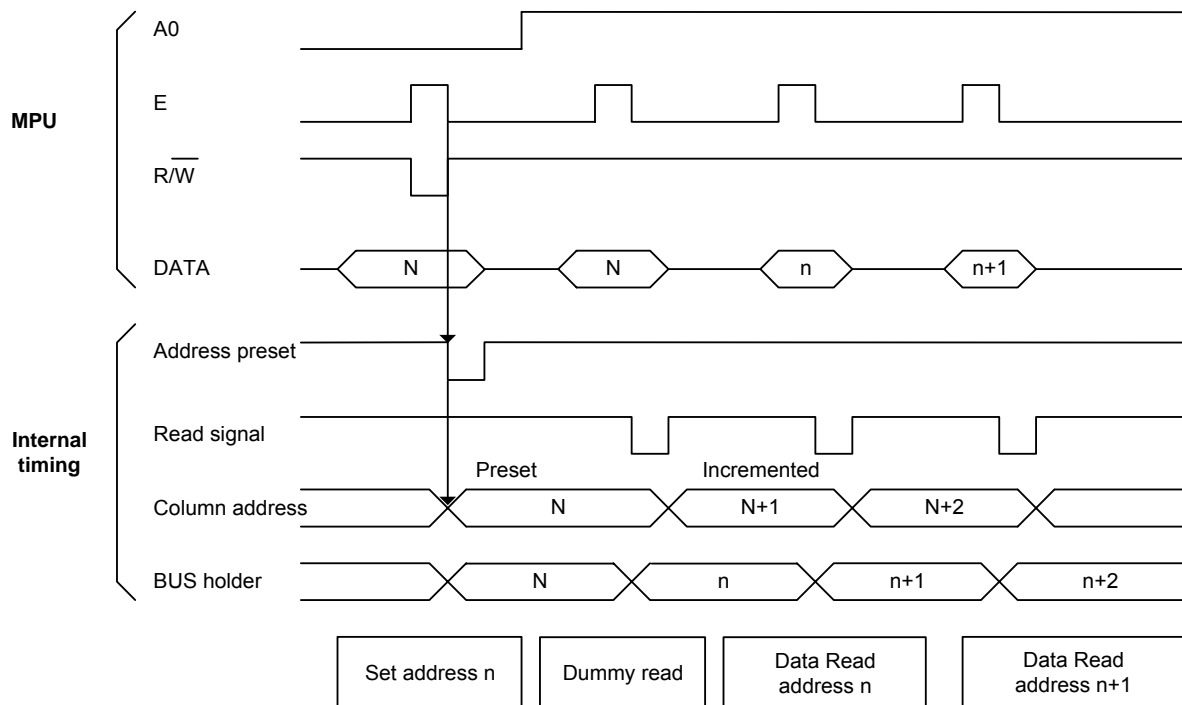
**6800-series Parallel Interface**

The parallel interface consists of 8 bi-directional data pads (D7-D0),  $\overline{WR}$  (R/ $\overline{W}$ ),  $\overline{RD}$  (E), A0 and  $\overline{CS}$ . When  $\overline{WR}$  (R/ $\overline{W}$ ) = "H", read operation from the display RAM or the status register occurs. When  $\overline{WR}$  (R/ $\overline{W}$ ) = "L", Write operation to display data RAM or internal command registers occurs, depending on the status of A0 input. The  $\overline{RD}$  (E) input serves as data latch signal (clock) when it is "H", provided that  $\overline{CS}$  = "L" as shown in Table. 2.

**Table. 2**

P/S	C86	Type	$\overline{CS}$	A0	$\overline{RD}$	$\overline{WR}$	D0 to D7
1	0	6800 microprocessor bus	$\overline{CS}$	A0	E	R/ $\overline{W}$	D0 to D7

In order to match the operating frequency of display RAM with that of the microprocessor, some pipeline processings are internally performed, which require the insertion of a dummy read before the first actual display data read. This is shown in Figure. 1 below.



**Figure. 1**





**8080-series Parallel Interface**

The parallel interface consists of 8 bi-directional data pads (D7-D0),  $\overline{WR}$  (R/ $\overline{W}$ ),  $\overline{RD}$  (E), A0 and  $\overline{CS}$ . The  $\overline{RD}$  (E) input serves as data read latch signal (clock) when it is "L" provided that  $\overline{CS}$  = "L". Display data or status register read is controlled by A0 signal. The  $\overline{WR}$  (R/ $\overline{W}$ ) input serves as data write latch signal (clock) when it is "L" and provided that  $\overline{CS}$  = "L". Display data or command register write is controlled by A0 as shown in Table. 3.

**Table. 3**

P/S	C86	Type	$\overline{CS}$	A0	$\overline{RD}$	$\overline{WR}$	D0 to D7
1	1	8080 microprocessor bus	$\overline{CS}$	A0	$\overline{RD}$	$\overline{WR}$	D0 to D7

Similar to 6800-series interface, a dummy read is also required before the first actual display data read.

**Data Bus Signals**

The SH1101A identifies the data bus signal according to A0,  $\overline{RD}$  (E) and  $\overline{WR}$  (R/ $\overline{W}$ ) signals.

**Table. 4**

Common	6800 processor	8080 processor		Function
		$\overline{RD}$	$\overline{WR}$	
A0	(R/ $\overline{W}$ )			
1	1	0	1	Reads display data.
1	0	1	0	Writes display data.
0	1	0	1	Reads status.
0	0	1	0	Writes control data in internal register. (Command)



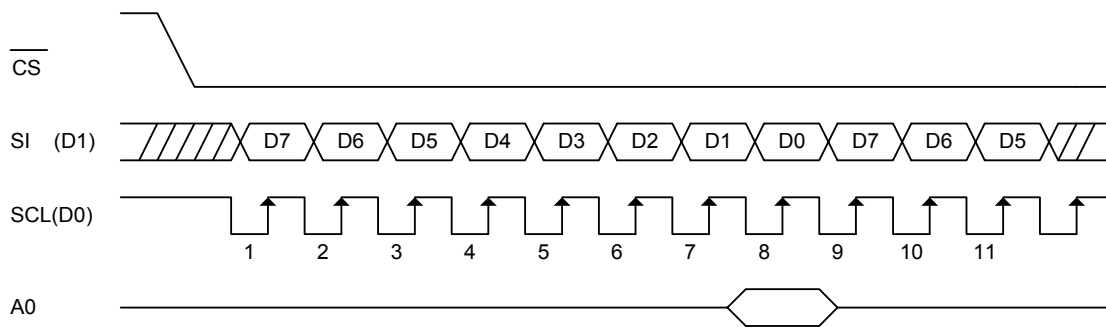
**Serial Interface (SPI)**

The serial interface consists of serial clock SCL, serial data SI, A0 and  $\overline{CS}$ . SI is shifted into an 8-bit shift register on every rising edge of SCL in the order of D7, D6, ... and D0. A0 is sampled on every eighth clock and the data byte in the shift register is written to the display data RAM or command register in the same clock. See Figure. 2.

**Table. 5**

P/S	C86	Type	$\overline{CS}$	A0	$\overline{RD}$	$\overline{WR}$	D0	D1	D2 to D7
0	0	Serial Interface (SPI)	$\overline{CS}$	A0	-	-	SCL	SI	(HZ)

**Note:** “-” Must always be HIGH or LOW.



**Figure. 2**

- When the chip is not active, the shift registers and the counter are reset to their initial statuses.
- Read is not possible while in serial interface mode.
- Caution is required on the SCL signal when it comes to line-end reflections and external noise. We recommend the operation be rechecked on the actual equipment.

**Access to Display Data RAM and Internal Registers**

This module determines whether the input data is interpreted as data or command. When A0 = “H”, the inputs at D7 - D0 are interpreted as data and be written to display RAM. When A0 = “L”, the inputs at D7 - D0 are interpreted as command, they will be decoded and be written to the corresponding command registers.

**Display Data RAM**

The Display Data RAM is a bit mapped static RAM holding the bit pattern to be displayed. The size of the RAM is 132 X 64 bits. For mechanical flexibility, re-mapping on both segment and common outputs can be selected by software. For vertical scrolling of the display, an internal register storing display start line can be set to control the portion of the RAM data to be mapped to the display.



**The Page Address Circuit**

As shown in Figure. 3, page address of the display data RAM is specified through the Page Address Set Command. The page address must be specified again when changing pages to perform access.

**The Column Address**

As shown in Figure. 3, the display data RAM column address is specified by the Column Address Set command. The specified column address is incremented (+1) with each display data read/ write command. This allows the MPU display data to be accessed continuously. Because the column address is independent of the page address, when moving, for example, from page0 column 83H to page 1 column 00H, it is necessary to re-specify both the page address and the column address.

Furthermore, as shown in Table. 6, the Column re-mapping (ADC) command (segment driver direction select command) can be used to reverse the relationship between the display data RAM column address and the segment output. Because of this, the constraints on the IC layout when the OLED module is assembled can be minimized.

**Table. 6**

Segment Output	SEG0	SEG131
ADC "0"	0 (H) →	Column Address → 83 (H)
ADC "1"	83 (H) ←	Column Address ← 0 (H)

**The Line Address Circuit**

The line address circuit, as shown in Figure. 3, specifies the line address relating to the common output when the contents of the display data RAM are displayed. Using the display start line address set command, what is normally the top line of the display can be specified (this is the COM0 output when the common output mode is normal, and the COM63 output for SH1101A, when the common output mode is reversed. The display area is a 64-line area for the SH1101A from the display start line address.

If the line addresses are changed dynamically using the display start line address set command, screen scrolling, page swapping, etc. that can be performed relationship between display data RAM and address (if initial display line is 1DH).



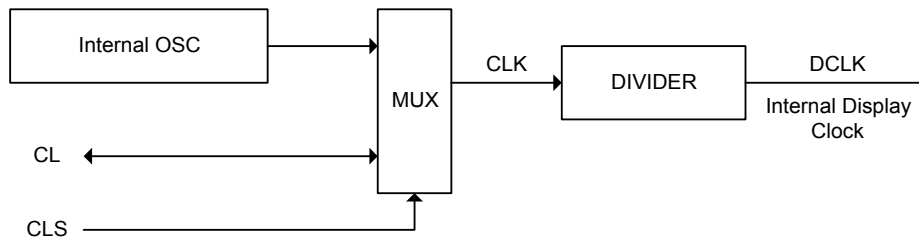
Page Address				Data							Line Address			OUTPUT																																																																																																																									
D3	D2	D1	D0	D0	PAGE 0	00H	COM0	01H	COM1	02H	COM2	03H	COM3	04H	COM4	05H	COM5	06H	COM6	07H	COM7																																																																																																																		
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				D5																																																																																														PAGE 5	2CH	COM44	2DH	COM45	2EH	COM46	2FH	COM47	30H	COM48	31H	COM49	32H	COM50	33H	COM51	34H	COM52																			
				D6																																																																																																																	PAGE 6	35H	COM53	36H	COM54	37H	COM55	38H	COM56	39H	COM57	3AH	COM58	3BH	COM59	3CH	COM60	3DH	COM61
				D7																																																																																																																																			
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Column Address	ADC	D0=1	D0=0	83H	PAGE 0	00H	COM0	01H	COM1	02H	COM2	03H	COM3	04H	COM4	05H	COM5	06H	COM6	07H	COM7																																																																																																																		
				82H																		PAGE 1	08H	COM8	09H	COM9	0AH	COM10	0BH	COM11	0CH	COM12	0DH	COM13	0EH	COM14	0FH	COM15	10H	COM16																																																																																															
				81H																																					PAGE 2	11H	COM17	12H	COM18	13H	COM19	14H	COM20	15H	COM21	16H	COM22	17H	COM23	18H	COM24	19H	COM25																																																																												
80H	PAGE 3	1AH	COM26	1BH	COM27	1CH	COM28	1DH	COM29	1EH	COM30	1FH	COM31	20H	COM32	21H	COM33	22H	COM34	23H	COM35																																																																																																																		
LCD OUT	SEG0	SEG1	SEG2		PAGE 0	00H	COM0	01H	COM1	02H	COM2	03H	COM3	04H	COM4	05H	COM5	06H	COM6	07H	COM7																																																																																																																		
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PAGE 3	19H	COM25	1AH	COM26	1BH	COM27	1CH	COM28	1DH	COM29	1EH	COM30	1FH	COM31	20H	COM32	21H	COM33	22H	COM34	23H	COM35																																																																																																																	
PAGE 4	24H	COM36	25H	COM37	26H	COM38	27H	COM39	28H	COM40	29H	COM41	2AH	COM42	2BH	COM43	2CH	COM44	2DH	COM45	2EH	COM46	2FH	COM47																																																																																																															
PAGE 5	30H	COM48	31H	COM49	32H	COM50	33H	COM51	34H	COM52	35H	COM53	36H	COM54	37H	COM55	38H	COM56	39H	COM57	3AH	COM58	3BH	COM59																																																																																																															
PAGE 6	3CH	COM60	3DH	COM61	3EH	COM62	3FH	COM63																																																																																																																															

Figure. 3



**The Oscillator Circuit**

This is a RC type oscillator (Figure. 4) that produces the display clock. The oscillator circuit is only enabled when CLS = "H". When CLS = "L", the oscillation stops and the display clock is inputted through the CL terminal.



**Figure. 4**



**DC-DC Voltage Converter**

It is a switching voltage generator circuit, designed for hand held applications. In SH1101A, built-in DC-DC voltage converter accompanied with an external application circuit (shown in Figure. 5) can generate a high voltage supply  $V_{PP}$  from a low voltage supply input  $V_{DD2}$ .  $V_{PP}$  is the voltage supply to the OLED driver block.

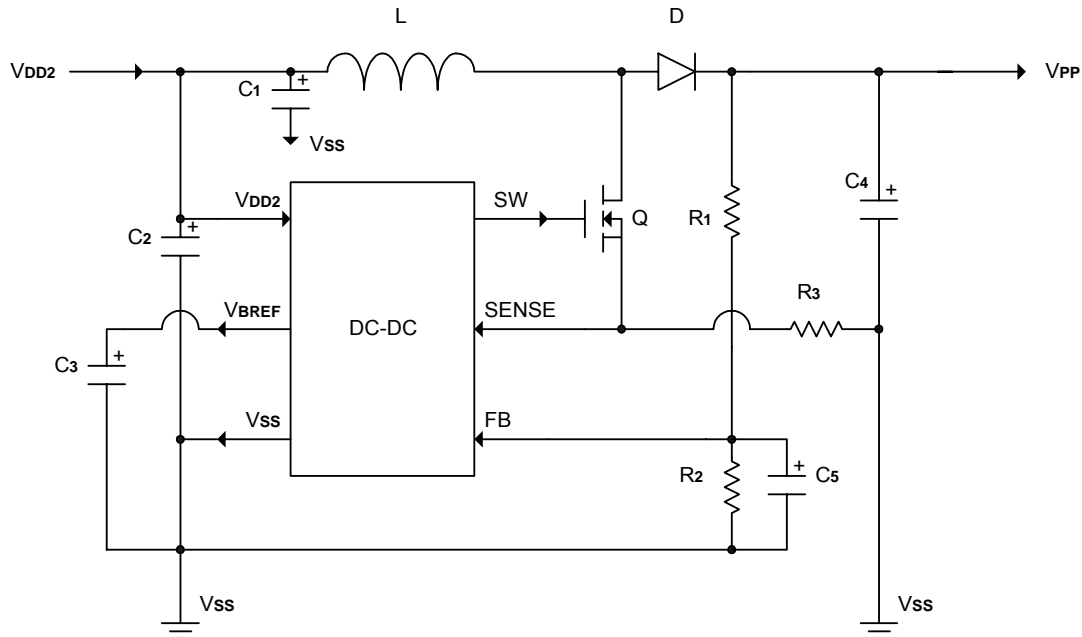


Figure. 5

$$V_{PP} = (1 + \frac{R1}{R2}) \times V_{BREF}, (R2: 80 - 120k\Omega)$$

**Current Control and Voltage Control**

This block is used to derive the incoming power sources into different levels of internal use voltage and current.  $V_{PP}$  and  $V_{DD2}$  are external power supplies.  $V_{REF}$ , a reference voltage, which is used to derive the driving voltage for segments and commons.  $I_{REF}$  is a reference current source for segment current drivers.

**Common Drivers/Segment Drivers**

Segment drivers deliver 132 current sources to drive OLED panel. The driving current can be adjusted up to 320 $\mu$ A with 256 steps. Common drivers generate voltage scanning pulses.

**Reset Circuit**

When the  $\overline{RES}$  input falls to "L", these reenter their default state. The default settings are shown below:

1. Display is OFF. Common and segment are in high impedance state.
2. 132 X 64 Display mode.
3. Normal segment and display data column address and row address mapping (SEG0 is mapped to column address 00H and COM0 mapped to row address 00H).
4. Shift register data clear in serial interface.
5. Display start line is set at display RAM line address 00H.
6. Column address counter is set at 0.
7. Normal scanning direction of the common outputs.
8. Contrast control register is set at 80H.
9. Internal DC-DC is selected.



**Commands**

The SH1101A uses a combination of A0,  $\overline{RD}$  (E) and  $\overline{WR}$  (R/ $\overline{W}$ ) signals to identify data bus signals. As the chip analyzes and executes each command using internal timing clock only regardless of external clock, its processing speed is very high and its busy check is usually not required. The 8080 series microprocessor interface enters a read status when a low pulse is input to the  $\overline{RD}$  pad and a write status when a low pulse is input to the  $\overline{WR}$  pad. The 6800 series microprocessor interface enters a read status when a high pulse is input to the R/ $\overline{W}$  pad and a write status when a low pulse is input to this pad. When a high pulse is input to the E pad, the command is activated. (For timing, see AC Characteristics.) Accordingly, in the command explanation and command table,  $\overline{RD}$  (E) becomes 1(HIGH) when the 6800 series microprocessor interface reads status of display data. This is an only different point from the 8080 series microprocessor interface.

Taking the 8080 series, microprocessor interface as an example command will explain below.

When the serial interface is selected, input data starting from D7 in sequence.

**Command Set**

1. Set Lower Column Address: (00H - 0FH)
2. Set Higher Column Address: (10H - 1FH)

Specifies column address of display RAM. Divide the column address into 4 higher bits and 4 lower bits. Set each of them into successions. When the microprocessor repeats to access to the display RAM, the column address counter is incremented during each access until address 132 is accessed. The page address is not changed during this time.

	A0	$\frac{E}{\overline{RD}}$	$\frac{R/\overline{W}}{\overline{WR}}$	D7	D6	D5	D4	D3	D2	D1	D0
Higher bits	0	1	0	0	0	0	1	A7	A6	A5	A4
Lower bits	0	1	0	0	0	0	0	A3	A2	A1	A0

A7	A6	A5	A4	A3	A2	A1	A0	Line address
0	0	0	0	0	0	0	0	0
0	0	0	0	0	0	0	1	1
			:					:
1	0	0	0	0	0	1	1	131

**Note:** Don't use any commands not mentioned above.

- 3 - 5. Reserved Command

These three commands are reserved for user.

6. Set Display Start Line: (40H - 7FH)

Specifies line address (refer to Figure. 3) to determine the initial display line or COM0. The RAM display data becomes the top line of OLED screen. It is followed by the higher number of lines in ascending order, corresponding to the duty cycle. When this command changes the line address, the smooth scrolling or page change takes place.

A0	$\frac{E}{\overline{RD}}$	$\frac{R/\overline{W}}{\overline{WR}}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	0	1	A5	A4	A3	A2	A1	A0

A5	A4	A3	A2	A1	A0	Line address
0	0	0	0	0	0	0
0	0	0	0	0	1	1
			:			:
1	1	1	1	1	0	62
1	1	1	1	1	1	63



7. Set Contrast Control Register: (Double Bytes Command)

This command is to set contrast setting of the display. The chip has 256 contrast steps from 00 to FF. The segment output current increases as the contrast step value increases.

Segment output current setting:  $I_{SEG} = \alpha/256 \times I_{REF} \times \text{scale factor}$

Where:  $\alpha$  is contrast step;  $I_{REF}$  is reference current equals 10 $\mu$ A; Scale factor = 32.

■ The Contrast Control Mode Set: (81H)

When this command is input, the contrast data register set command becomes enabled. Once the contrast control mode has been set, no other command except for the contrast data register command can be used. Once the contrast data set command has been used to set data into the register, then the contrast control mode is released.

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{WR}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	0	0	0	0	0	0	1

■ Contrast Data Register Set: (00H - FFH)

By using this command to set eight bits of data to the contrast data register; the OLED segment output assumes one of the 256 current levels.

When this command is input, the contrast control mode is released after the contrast data register has been set.

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{WR}$	D7	D6	D5	D4	D3	D2	D1	D0	I <sub>SEG</sub>
0	1	0	0	0	0	0	0	0	0	0	Small
0	1	0	0	0	0	0	0	0	1	0	
0	1	0	0	0	0	0	0	0	1	1	
0	1	0					:				:
0	1	0	1	0	0	0	0	0	0	0	POR
0	1	0					:				:
0	1	0	1	1	1	1	1	1	1	0	
0	1	0	1	1	1	1	1	1	1	1	Large

When the contrast control function is not used, set the D7 - D0 to 1000,0000.

8. Set Segment Re-map: (A0H - A1H)

Change the relationship between RAM column address and segment driver. The order of segment driver output pads can be reversed by software. This allows flexible IC layout during OLED module assembly. For details, refer to the column address section of Figure. 3. When display data is written or read, the column address is incremented by 1 as shown in Figure. 1.

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{WR}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	0	1	0	0	0	0	ADC

When ADC = "L", the right rotates (normal direction). (POR)

When ADC = "H", the left rotates (reverse direction).

9. Set Entire Display OFF/ON: (A4H - A5H)

Forcibly turns the entire display on regardless of the contents of the display data RAM. At this time, the contents of the display data RAM are held.

This command has priority over the normal/reverse display command.

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{WR}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	0	1	0	0	1	0	D

When D = "L", the normal display status is provided. (POR)

When D = "H", the entire display ON status is provided.





10. Set Normal/Reverse Display: (A6H -A7H)

Reverses the display ON/OFF status without rewriting the contents of the display data RAM.

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{WR}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	0	1	0	0	1	1	D

When D = "L", the RAM data is high, being OLED ON potential (normal display). (POR)

When D = "H", the RAM data is low, being OLED ON potential (reverse display)

11. Set Multiplex Ratio: (Double Bytes Command)

This command switches default 64 multiplex modes to any multiplex ratio from 1 to 64. The output pads COM0-COM63 will be switched to corresponding common signal.

■ Multiplex Ratio Mode Set: (A8H)

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{WR}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	0	1	0	1	0	0	0

■ Multiplex Ratio Data Set: (00H - 3FH)

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{WR}$	D7	D6	D5	D4	D3	D2	D1	D0	Multiplex Ratio
0	1	0	*	*	0	0	0	0	0	0	1
0	1	0	*	*	0	0	0	0	1	0	2
0	1	0	*	*	0	0	0	0	1	1	3
0	1	0					:				:
0	1	0	*	*	1	1	1	1	1	0	63
0	1	0	*	*	1	1	1	1	1	1	64 (POR)

12. Set DC-DC OFF/ON: (Double Bytes Command)

This command is to control the DC-DC voltage converter. The converter will be turned on by issuing this command then display ON command. The panel display must be off while issuing this command.

■ DC-DC Control Mode Set: (ADH)

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{WR}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	0	1	0	1	1	0	1

■ DC-DC ON/OFF Mode Set: (8AH - 8BH)

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{WR}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	0	0	0	1	0	1	D

When D = "L", DC-DC is disable.

When D = "H", DC-DC will be turned on when display on. (POR)

Table. 7

DC-DC STATUS	DISPLAY ON/OFF STATUS	Description
0	0	Sleep mode
0	1	External VPP must be used.
1	0	Sleep mode
1	1	Built-in DC-DC is used, Normal Display



13. Display OFF/ON: (AEH - AFH)

Alternatively turns the display on and off.

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{\overline{WR}}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	0	1	0	1	1	1	D

When D = "L", Display OFF OLED. (POR)

When D = "H", Display ON OLED.

When the display OFF command is executed, power saver mode will be entered.

Sleep mode:

This mode stops every operation of the OLED display system, and can reduce current consumption nearly to a static current value if no access is made from the microprocessor. The internal status in the sleep mode is as follows:

- (1) Stops the oscillator circuit and DC-DC circuit.
- (2) Stops the OLED drive and outputs HZ as the segment/common driver output.
- (3) Holds the display data and operation mode provided before the start of the sleep mode.
- (4) The MPU can access to the built-in display RAM.

14. Set Page Address: (B0H - B7H)

Specifies page address to load display RAM data to page address register. Any RAM data bit can be accessed when its page address and column address are specified. The display remains unchanged even when the page address is changed.

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{\overline{WR}}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	0	1	1	A3	A2	A1	A0

A3	A2	A1	A0	Page address
0	0	0	0	0
0	0	0	1	1
0	0	1	0	2
0	0	1	1	3
0	1	0	0	4
0	1	0	1	5
0	1	1	0	6
0	1	1	1	7

**Note:** Don't use any commands not mentioned above for user.



15. Set Common Output Scan Direction: (C0H - C8H)

This command sets the scan direction of the common output allowing layout flexibility in OLED module design. In addition, the display will have immediate effect once this command is issued. That is, if this command is sent during normal display, the graphic display will be vertically flipped.

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{WR}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	0	0	D	*	*	*

When D = "L", Scan from COM0 to COM [N -1]. (POR)

When D = "H", Scan from COM [N -1] to COM0.

16. Set Display Offset: (Double Bytes Command)

This is a double byte command. The next command specifies the mapping of display start line to one of COM0-63 (it is assumed that COM0 is the display start line, that equals to 0). For example, to move the COM16 towards the COM0 direction for 16 lines, the 6-bit data in the second byte should be given by 010000. To move in the opposite direction by 16 lines, the 6-bit data should be given by (64-16), so the second byte should be 100000.

■ Display Offset Mode Set: (D3H)

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{WR}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	0	1	0	0	1	1

■ Display Offset Data Set: (00H~3FH)

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{WR}$	D7	D6	D5	D4	D3	D2	D1	D0	COMx
0	1	0	*	*	0	0	0	0	0	0	0 (POR)
0	1	0	*	*	0	0	0	0	1	0	1
0	1	0	*	*	0	0	0	0	1	1	2
0	1	0					:				:
0	1	0	*	*	1	1	1	1	1	0	62
0	1	0	*	*	1	1	1	1	1	1	63

Note: "\*" stands for "Don't care"



17. Set Display Clock Divide Ratio/Oscillator Frequency: (Double Bytes Command)

This command is used to set the frequency of the internal display clocks (DCLKs). It is defined as the divide ratio (Value from 1 to 16) used to divide the oscillator frequency. POR is 1. Frame frequency is determined by divide ratio, number of display clocks per row, MUX ratio and oscillator frequency.

■ Divide Ratio/Oscillator Frequency Mode Set: (D5H)

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{WR}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	0	1	0	1	0	1

■ Divide Ratio/Oscillator Frequency Data Set: (00H - 3FH)

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{WR}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	A7	A6	A5	A4	A3	A2	A1	A0

A3 - A0 defines the divide ration of the display clocks (DCLK). Divide Ratio = A[3:0]+1.

A3	A2	A1	A0	Divide Ratio
0	0	0	0	1 (POR)
		:		:
1	1	1	1	16

A7 - A4 sets the oscillator frequency. Oscillator frequency increase with the value of A[7:4] and vice versa.

A7	A6	A5	A4	Oscillator Frequency of $f_{osc}$
0	0	0	0	-25%
0	0	0	1	-20%
0	0	1	0	-15%
0	0	1	1	-10%
0	1	0	0	-5%
0	1	0	1	$f_{osc}$ (POR)
0	1	1	0	+5%
0	1	1	1	+10%
1	0	0	0	+15%
1	0	0	1	+20%
1	0	1	0	+25%
1	0	1	1	+30%
1	1	0	0	+35%
1	1	0	1	+40%
1	1	1	0	+45%
1	1	1	1	+50%



18. Set Dis-charge/Pre-charge Period: (Double Bytes Command)

This command is used to set the duration of the pre-charge period. The interval is counted in number of DCLK. POR is 2 DCLKs.

■ Pre-charge Period Mode Set: (D9H)

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{\overline{WR}}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	0	1	1	0	0	1

■ Dis-charge/Pre-charge Period Data Set: (00H - FFH)

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{\overline{WR}}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	A7	A6	A5	A4	A3	A2	A1	A0

Pre-charge Period Adjust: (A3 - A0)

A3	A2	A1	A0	Pre-charge Period
0	0	0	0	INVALID
0	0	0	1	1 DCLKs
0	0	1	0	2 DCLKs (POR)
		:		:
1	1	1	0	14 DCLKs
1	1	1	1	15 DCLKs

Dis-charge Period Adjust: (A7 - A4)

A7	A6	A5	A4	Dis-charge Period
0	0	0	0	INVALID
0	0	0	1	1 DCLKs
0	0	1	0	2 DCLKs (POR)
		:		:
1	1	1	0	14 DCLKs
1	1	1	1	15 DCLKs

19. Set Common pads hardware configuration: (Double Bytes Command)

This command is to set the common signals pad configuration (sequential or alternative) to match the OLED panel hardware layout

■ Common Pads Hardware Configuration Mode Set: (DAH)

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{\overline{WR}}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	0	1	1	0	1	0

■ Sequential/Alternative Mode Set: (02H - 12H)

A0	$\frac{E}{RD}$	$\frac{R/\overline{W}}{\overline{WR}}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	0	0	0	D	0	0	1	0

When D = "L", Sequential.

COM31, 30 - 1, 0	SEG0, 1 - 130, 131	COM32, 33 - 62, 63
------------------	--------------------	--------------------

When D = "H", Alternative. (POR)

COM62, 60 - 2, 0	SEG0, 1 - 130, 131	COM1, 3 - 61, 63
------------------	--------------------	------------------



20. Set VCOM Deselect Level: (Double Bytes Command)

This command is to set the common pad output voltage level at deselect stage.

■ VCOM Deselect Level Mode Set: (DBH)

A0	$\overline{E}$ $\overline{RD}$	$\overline{R/W}$ $\overline{WR}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	0	1	1	0	1	1

■ VCOM Deselect Level Data Set: (00H - FFH)

A0	$\overline{E}$ $\overline{RD}$	$\overline{R/W}$ $\overline{WR}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	A7	A6	A5	A4	A3	A2	A1	A0

$$V_{COM} = \beta \times V_{REF} = (0.430 + A[7:0] \times 0.006415) \times V_{REF}$$

A[7:0]	$\beta$	A[7:0]	$\beta$		
00H	0.430	20H	0.770 (POR)		
01H					
02H					
03H					
04H					
05H					
06H					
07H					
08H					
09H					
0AH					
0BH					
0CH					
0DH					
0EH					
0FH					
10H					
11H					
12H					
13H					
14H					
15H					
16H					
17H					
18H					
19H					
1AH					
1BH					
1CH					
1DH					
1EH					
1FH					
40H - FFH		1			



21. Read-Modify-Write: (E0H)

A pair of Read-Modify-Write and End commands must always be used. Once read-modify-write is issued, column address is not incremental by read display data command but incremental by write display data command only. It continues until End command is issued. When the End is issued, column address returns to the address when read-modify-write is issued. This can reduce the microprocessor load when data of a specific display area is repeatedly changed during cursor blinking or others.

A0	$\overline{E}$ RD	$\overline{R/W}$ WR	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	1	0	0	0	0	0

Cursor display sequence:

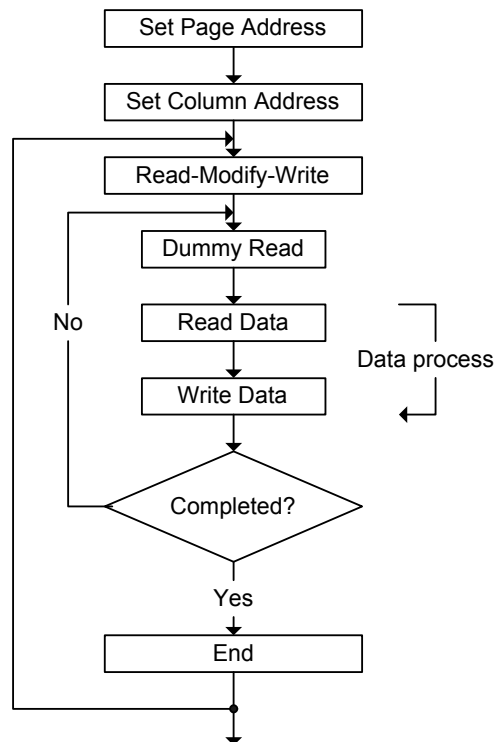


Figure. 6

22. End: (EEH)

Cancels Read-Modify-Write mode and returns column address to the original address (when Read-Modify-Write is issued.)

A0	$\overline{E}$ RD	$\overline{R/W}$ WR	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	1	0	1	1	1	0

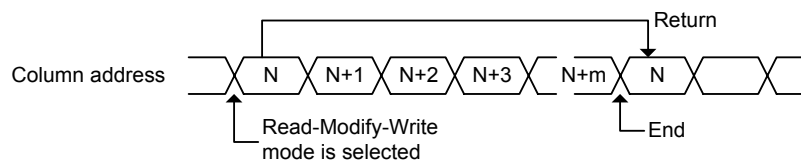


Figure. 7



23. NOP: (E3H)

Non-Operation Command.

A0	$\overline{E}$ RD	$\overline{R/W}$ WR	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	1	0	0	0	1	1

24. Write Display Data

Write 8-bit data in display RAM. As the column address is incremental by 1 automatically after each write, the microprocessor can continue to write data of multiple words.

A0	$\overline{E}$ RD	$\overline{R/W}$ WR	D7	D6	D5	D4	D3	D2	D1	D0
1	1	0	Write RAM data							

25. Read Status

A0	$\overline{E}$ RD	$\overline{R/W}$ WR	D7	D6	D5	D4	D3	D2	D1	D0
0	0	1	BUSY	ON/OFF	*	*	*	0	0	0

BUSY: When high, the SH1101A is busy due to internal operation or reset. Any command is rejected until BUSY goes low. The busy check is not required if enough time is provided for each cycle.

ON/OFF: Indicates whether the display is on or off. When goes low the display turns on. When goes high, the display turns off. This is the opposite of Display ON/OFF command.

26. Read Display Data

Reads 8-bit data from display RAM area specified by column address and page address. As the column address is increment by 1 automatically after each write, the microprocessor can continue to read data of multiple words. A single dummy read is required immediately after column address being setup. Refer to the display RAM section of FUNCTIONAL DESCRIPTION for details. Note that no display data can be read via the serial interface.

A0	$\overline{E}$ RD	$\overline{R/W}$ WR	D7	D6	D5	D4	D3	D2	D1	D0
1	0	1	Read RAM data							





Command Table

Command	Code											Function	
	A0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0		
1. Set Column Address 4 lower bits	0	1	0	0	0	0	0	Lower column address				0	Sets 4 lower bits of column address of display RAM in register. (POR = 00H)
2. Set Column Address 4 higher bits	0	1	0	0	0	0	1	Higher column address				0	Sets 4 higher bits of column address of display RAM in register. (POR = 10H)
3. Reserved Command	0	1	0	0	0	1	0	0	1	0	0	0	Reserved
4. Reserved Command	0	1	0	0	0	1	0	0	1	1	0	0	Reserved
5. Reserved Command	0	1	0	0	0	1	0	1	1	1	D	D	Reserved
6. Set Display Start Line	0	1	0	0	1	Line address					0	0	Specifies RAM display line for COM0. (POR = 40H)
7. The Contrast Control Mode Set	0	1	0	1	0	0	0	0	0	0	0	1	This command is to set Contrast Setting of the display. The chip has 256 contrast steps from 00 to FF. (POR = 80H)
Contrast Data Register Set	0	1	0	Contrast Data							0	0	
8. Set Segment Re-map (ADC)	0	1	0	1	0	1	0	0	0	0	0	ADC	The right (0) or left (1) rotation. (POR = A0H)
9. Set Entire Display OFF/ON	0	1	0	1	0	1	0	0	1	0	0	D	Selects normal display (0) or Entire Display ON (1). (POR = A4H)
10. Set Normal/Reverse Display	0	1	0	1	0	1	0	0	1	1	0	D	Normal indication (0) when low, but reverse indication (1) when high. (POR = A6H)
11. Multiplex Ration Mode Set	0	1	0	1	0	1	0	1	0	0	0	0	This command switches default 63 multiplex mode to any multiplex ratio from 1 to 64. (POR = 3FH)
Multiplex Ration Data Set	0	1	0	*	*	Multiplex Ratio					0	0	
12. DC-DC Control Mode Set	0	1	0	1	0	1	0	1	1	0	1	1	This command is to control the DC-DC voltage DC-DC will be turned on when display on converter (1) or DC-DC OFF (0). (POR = 8BH)
DC-DC ON/OFF Mode Set	0	1	0	1	0	0	0	1	0	1	D	D	



Command Table (Continued)

Command	Code											Function
	A0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0	
13. Display OFF/ON	0	1	0	1	0	1	0	1	1	1	D	Turns on OLED panel (1) or turns off (0). (POR = AEH)
14. Set Page Address	0	1	0	1	0	1	1	Page Address				Specifies page address to load display RAM data to page address register. (POR = B0H)
15. Set Common Output Scan Direction	0	1	0	1	1	0	0	D	*	*	*	Scan from COM0 to COM [N - 1] (0) or Scan from COM [N -1] to COM0 (1). (POR = C0H)
16. Display Offset Mode Set	0	1	0	1	1	0	1	0	0	1	1	This is a double byte command which specifies the mapping of display start line to one of COM0-63. (POR = 00H)
Display Offset Data Set	0	1	0	*	*	COMx						
17. Set Display Divide Ratio/Oscillator Frequency Mode Set	0	1	0	1	1	0	1	0	1	0	1	This command is used to set the frequency of the internal display clocks. (POR = 50H)
Divide Ratio/Oscillator Frequency Data Set	0	1	0	Oscillator Frequency				Divide Ratio				
18. Dis-charge / Pre-charge Period Mode Set	0	1	0	1	1	0	1	1	0	0	1	This command is used to set the duration of the dis-charge and pre-charge period. (POR = 22H)
Dis-charge /Pre-charge Period Data Set	0	1	0	Dis-charge Period				Pre-charge Period				
19. Common Pads Hardware Configuration Mode Set	0	1	0	1	1	0	1	1	0	1	0	This command is to set the common signals pad configuration. (POR = 12H)
Sequential/Alternative Mode Set	0	1	0	0	0	0	D	0	0	1	0	
20. VCOM Deselect Level Mode Set	0	1	0	1	1	0	1	1	0	1	1	This command is to set the common pad output voltage level at deselect stage. (POR = 35H)
VCOM Deselect Level Data Set	0	1	0	VCOM ( $\beta \times V_{REF}$ )								
21. Read-Modify-Write	0	1	0	1	1	1	0	0	0	0	0	Read-Modify-Write start.
22. End	0	1	0	1	1	1	0	1	1	1	0	Read-Modify-Write end.
23. NOP	0	1	0	1	1	1	0	0	0	1	1	Non-Operation Command
24. Write Display Data	1	1	0	Write RAM data								
25. Read Status	0	0	1	BUSY	ON/OFF	*	*	*	0	0	0	
26. Read Display Data	1	0	1	Read RAM data								

**Note:** Do not use any other command, or the system malfunction may result.

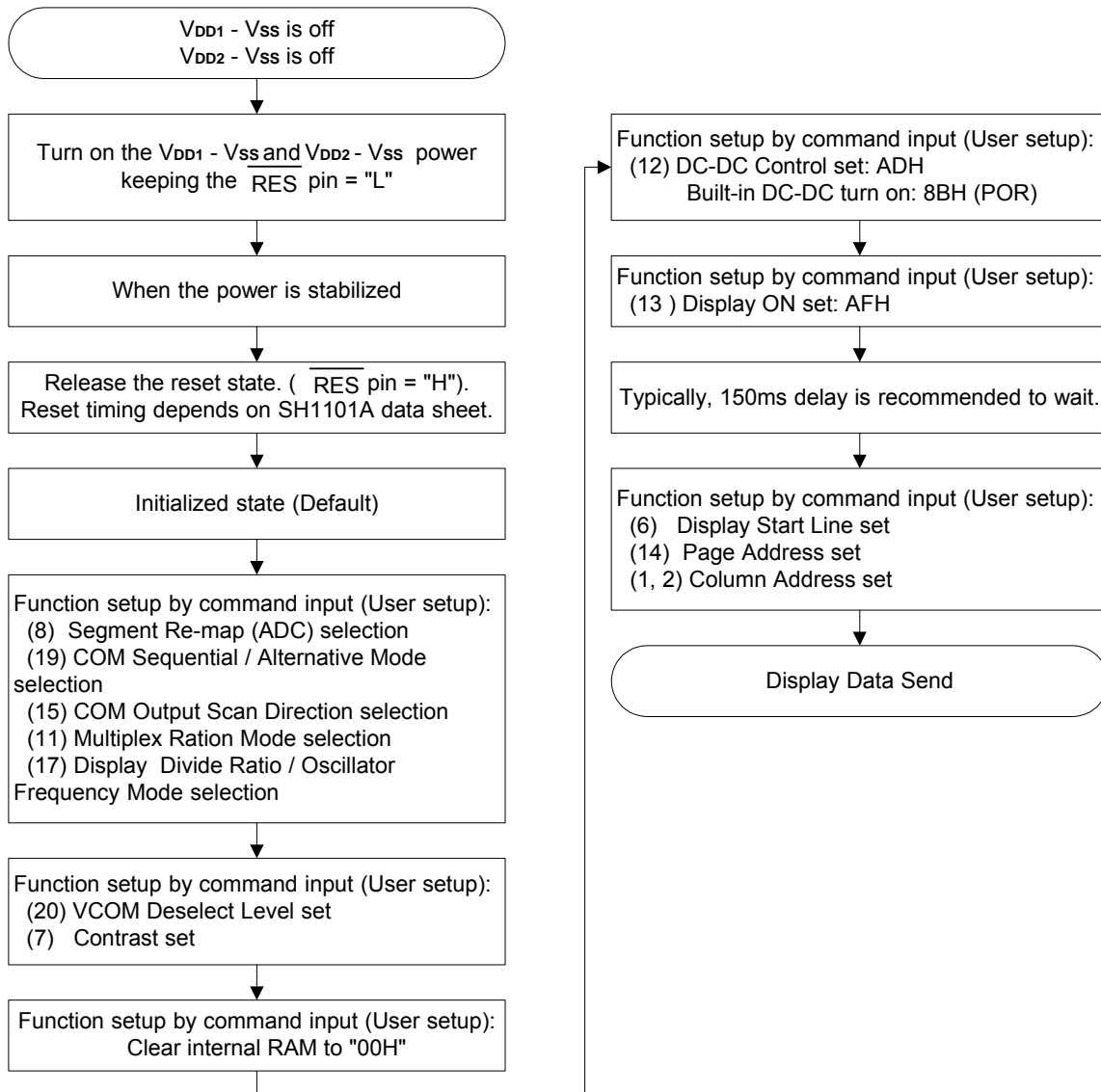


### Command Description

#### Instruction Setup: Reference

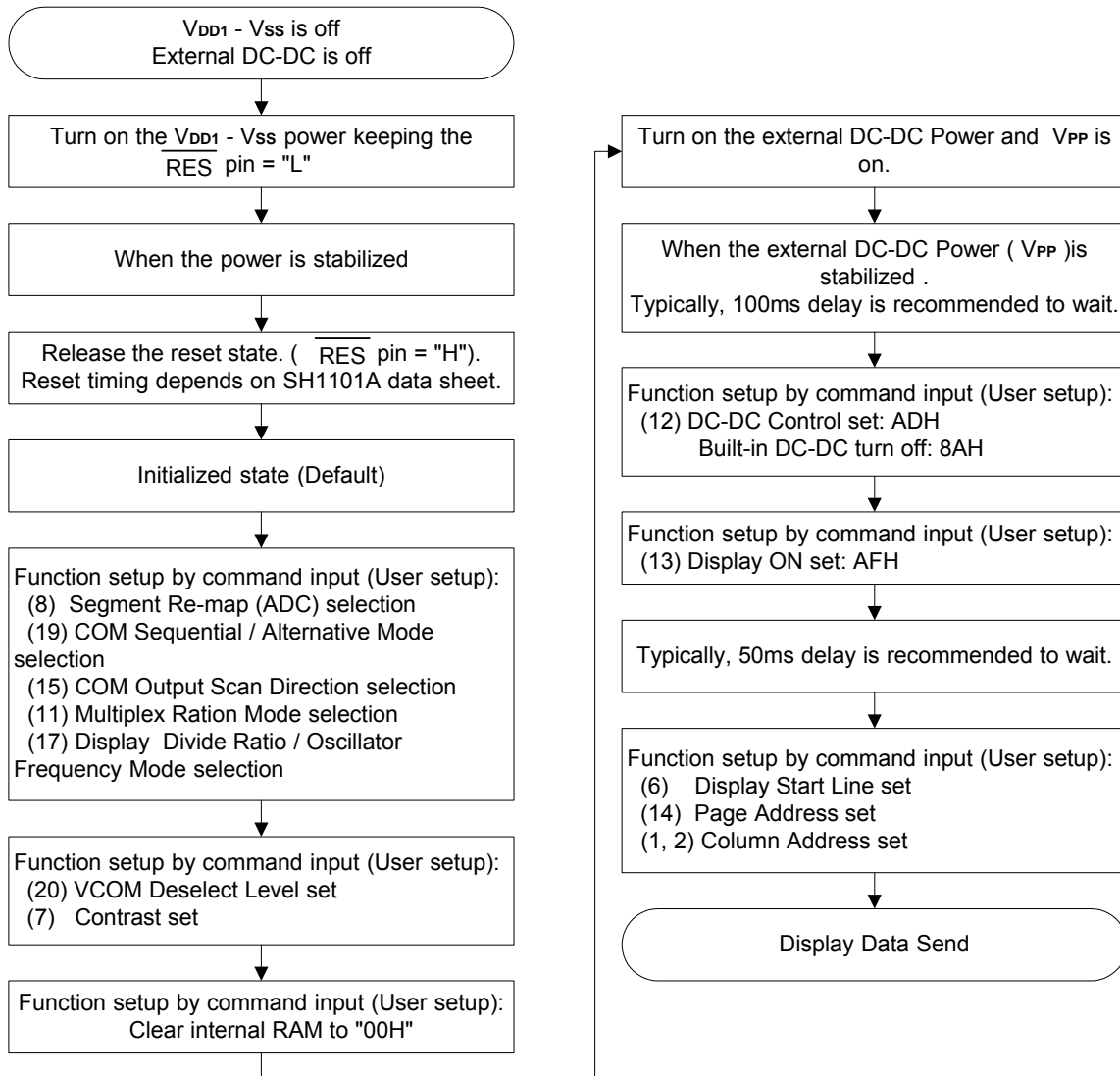
#### 1. Power On and Initialization

##### 1.1. When the built-in DC-DC pump power is being used immediately after turning on the power:



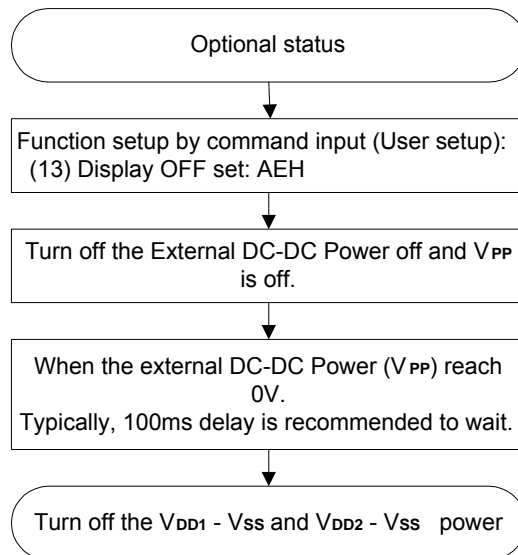


1.2. When the external DC-DC pump power is being used immediately after turning on the power:





2. Power Off





**Absolute Maximum Rating\***

DC Supply Voltage (VDD1, VDD2) . . . . . -0.3V to +3.6V  
 DC Supply Voltage (VPP) . . . . . -0.3V to +18V  
 Input Voltage . . . . . -0.3V to VDD1 + 0.3V  
 Operating Ambient Temperature . . . . . -40°C to +85°C  
 Storage Temperature . . . . . -55°C to +125°C

**\*Comments**

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to this device. These are stress ratings only. Functional operation of this device under these or any other conditions above those indicated in the operational sections of this specification is not implied or intended. Exposure to the absolute maximum rating conditions for extended periods may affect device reliability.

**Electrical Characteristics**

**DC Characteristics** (Vss = 0V, VDD1 = 2.4 - 3.5V TA = +25°C, unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit	Condition
VDD1	Operating voltage	2.4	-	3.5	V	
VDD2	Operating voltage	2.4	-	3.5	V	
VPP	OLED Operating voltage	7.0	-	16.0	V	
VBREF	Internal voltage reference	1.20	1.26	1.32	V	With one 1μF capacitor
IDD1	Dynamic current consumption 1	-	110	160	μA	VDD1 = 3V, VDD2 = 3V, IREF = 10μA, Contrast α = 256, Bulid-in DC-DC OFF, Display ON, display data = All ON, No panel attached.
IDD2	Dynamic current consumption 2	-	190	285	μA	VDD1 = 3V, VDD2 = 3V, VPP = 12V, IREF = -10μA, Contrast α = 256, Bulid-in DC-DC ON, Display ON, Display data = All ON, No panel attached.
IPP	OLED dynamic current consumption	-	550	825	μA	VDD1 = 3V, VDD2 = 3V, VPP = 12V, IREF = -10μA, Contrast α = 256, Display ON, All ON, No panel attached.
ISP	Sleep mode current consumption in VDD1 & VDD2	-	0.01	5	μA	During sleep, TA = +25°C, VDD1 = 3V, VDD2 = 3V.
	Sleep mode current consumption in VPP	-	0.01	5	μA	During sleep, TA = +25°C, VPP = 12V.
ISEG	Segment output current	-308	-320	-342	μA	VDD1 = 3V, VPP = 12V, IREF = -10μA, RLOAD = 20kΩ, Display ON. Contrast α = 256.
		-	-220	-	μA	VDD1 = 3V, VPP = 12V, IREF = -10μA, RLOAD = 20kΩ, Display ON. Contrast α = 176.
		-	-120	-	μA	VDD1 = 3V, VPP = 12V, IREF = -10μA, RLOAD = 20kΩ, Display ON. Contrast α = 96.
		-	-20	-	μA	VDD1 = 3V, VPP = 12V, IREF = -10μA, RLOAD = 20kΩ, Display ON. Contrast α = 16.
ΔISEG1	Segment output current uniformity	-	-	±3	%	ΔISEG1 = (ISEG - IMID)/IMID X 100% IMID = (IMAX + IMIN)/2 ISEG [0:131] at contrast α = 256.
ΔISEG2	Adjacent segment output current uniformity	-	-	±2	%	ΔISEG2 = (ISEG [N] - ISEG [N+1])/(ISEG [N] + ISEG [N+1]) X 100% ISEG [0:131] at contrast α = 256.



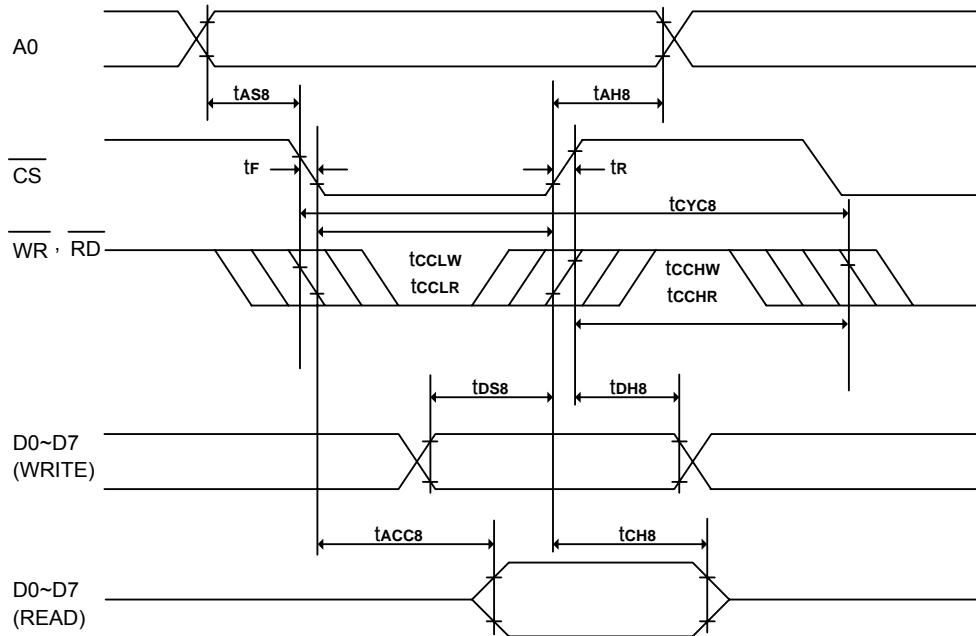
DC Characteristics (Continued)

Symbol	Parameter	Min.	Typ.	Max.	Unit	Condition
V <sub>IHC</sub>	High-level input voltage	0.8 X V <sub>DD1</sub>	-	V <sub>DD1</sub>	V	A0, D0 - D7, $\overline{RD}$ (E), $\overline{WR}$ (R/ $\overline{W}$ ), $\overline{CS}$ , CLS, CL, C86, P/S and $\overline{RES}$ .
V <sub>ILC</sub>	Low-level input voltage	V <sub>SS</sub>	-	0.2 X V <sub>DD1</sub>	V	
V <sub>OHC</sub>	High-level output voltage	0.8 X V <sub>DD1</sub>	-	V <sub>DD1</sub>	V	I <sub>OH</sub> = -0.5mA (D0 - D7, and CL).
V <sub>OLC</sub>	Low -level output voltage	V <sub>SS</sub>	-	0.2 X V <sub>DD1</sub>	V	I <sub>OL</sub> = 0.5mA (D0 - D7, and CL).
I <sub>LI</sub>	Input leakage current	-1.0	-	1.0	μA	V <sub>IN</sub> = V <sub>DD1</sub> or V <sub>SS</sub> (A0, $\overline{RD}$ (E), $\overline{WR}$ (R/ $\overline{W}$ ), $\overline{CS}$ , CLS, C86, P/S and $\overline{RES}$ ).
I <sub>HZ</sub>	HZ leakage current	-1.0	-	1.0	μA	When the D0 - D7, and CL are in high impedance.
f <sub>osc</sub>	Oscillation frequency	315	360	420	kHz	T <sub>A</sub> = +25°C.
f <sub>FRM</sub>	Frame frequency for 64 Commons	-	104	-	Hz	When f <sub>osc</sub> = 360kHz, Divide ratio = 1, common width = 54 DCLKs.



AC Characteristics

(1) System buses Read/Write characteristics 1 (For the 8080 Series Interface MPU)



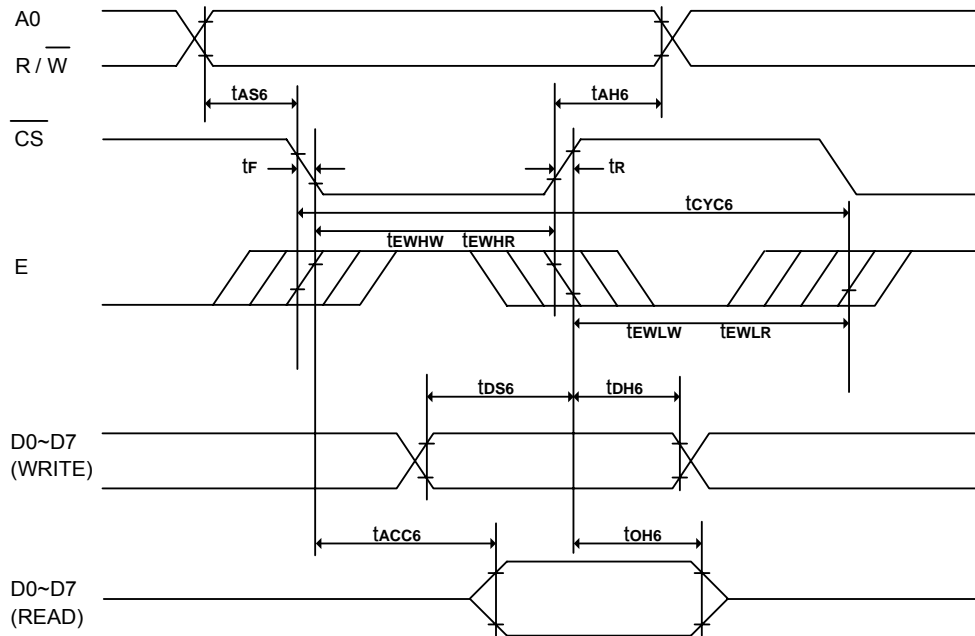
( $V_{DD1} = 2.4 - 3.5V$ ,  $T_A = +25^\circ C$ )

Symbol	Parameter	Min.	Typ.	Max.	Unit	Condition
$t_{CYC8}$	System cycle time	300	-	-	ns	
$t_{AS8}$	Address setup time	0	-	-	ns	
$t_{AH8}$	Address hold time	0	-	-	ns	
$t_{DS8}$	Data setup time	40	-	-	ns	
$t_{DH8}$	Data hold time	15	-	-	ns	
$t_{CH8}$	Output disable time	10	-	70	ns	$C_L = 100pF$
$t_{ACC8}$	$\overline{RD}$ access time	-	-	140	ns	$C_L = 100pF$
$t_{CCLW}$	Control L pulse width (WR)	100	-	-	ns	
$t_{CCLR}$	Control L pulse width (RD)	120	-	-	ns	
$t_{CCHW}$	Control H pulse width (WR)	100	-	-	ns	
$t_{CCHR}$	Control H pulse width (RD)	100	-	-	ns	
$t_R$	Rise time	-	-	15	ns	
$t_F$	Fall time	-	-	15	ns	





(2) System buses Read/Write Characteristics 2 (For the 6800 Series Interface MPU)

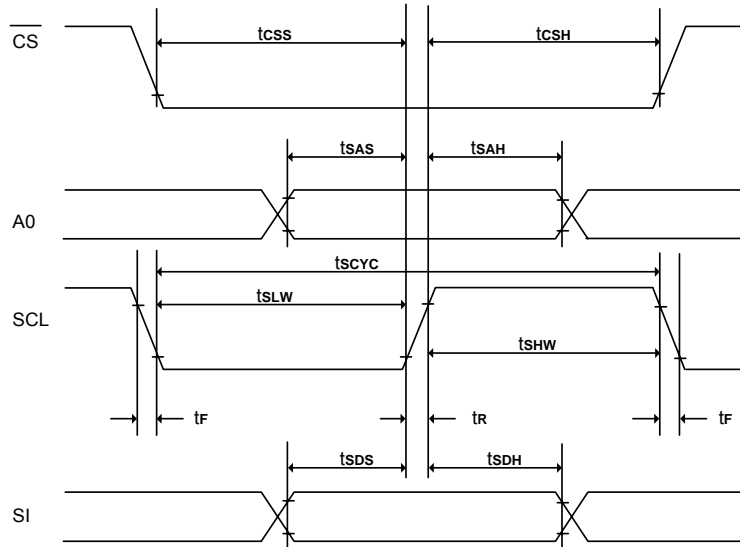


(VDD1 = 2.4 - 3.5V, TA = +25°C)

Symbol	Parameter	Min.	Typ.	Max.	Unit	Condition
tCYC6	System cycle time	300	-	-	ns	
tAS6	Address setup time	0	-	-	ns	
tAH6	Address hold time	0	-	-	ns	
tDS6	Data setup time	40	-	-	ns	
tDH6	Data hold time	15	-	-	ns	
tOH6	Output disable time	10	-	70	ns	CL = 100pF
tACC6	Access time	-	-	140	ns	CL = 100pF
tEWHW	Enable H pulse width (Write)	100	-	-	ns	
tEWHR	Enable H pulse width (Read)	120	-	-	ns	
tEWLW	Enable L pulse width (Write)	100	-	-	ns	
tEWLR	Enable L pulse width (Read)	100	-	-	ns	
tR	Rise time	-	-	15	ns	
tF	Fall time	-	-	15	ns	



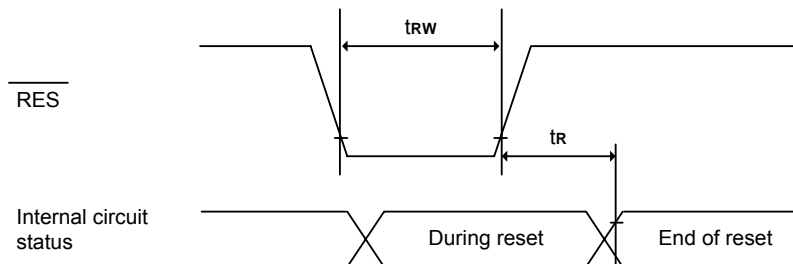
(3) System buses Write characteristics 3(For the Serial Interface MPU)



(VDD1 = 2.4 - 3.5V, TA = +25°C)

Symbol	Parameter	Min.	Typ.	Max.	Unit	Condition
tscyC	Serial clock cycle	250	-	-	ns	
tsAS	Address setup time	150	-	-	ns	
tsAH	Address hold time	150	-	-	ns	
tsDS	Data setup time	100	-	-	ns	
tsDH	Data hold time	100	-	-	ns	
tcSS	$\overline{CS}$ setup time	120	-	-	ns	
tcSH	$\overline{CS}$ hold time	60	-	-	ns	
tsHW	Serial clock H pulse width	100	-	-	ns	
tsLW	Serial clock L pulse width	100	-	-	ns	
tR	Rise time	-	-	15	ns	
tF	Fall time	-	-	15	ns	

(4) Reset Timing



(VDD1 = 2.4 - 3.5V, TA = +25°C)

Symbol	Parameter	Min.	Typ.	Max.	Unit	Condition
tR	Reset time	-	-	1.0	$\mu$ s	
tRW	Reset low pulse width	5.0	-	-	$\mu$ s	



Application Circuit (for reference only)

Reference Connection to MPU:

1. 8080 series interface: (Internal oscillator, External VPP)

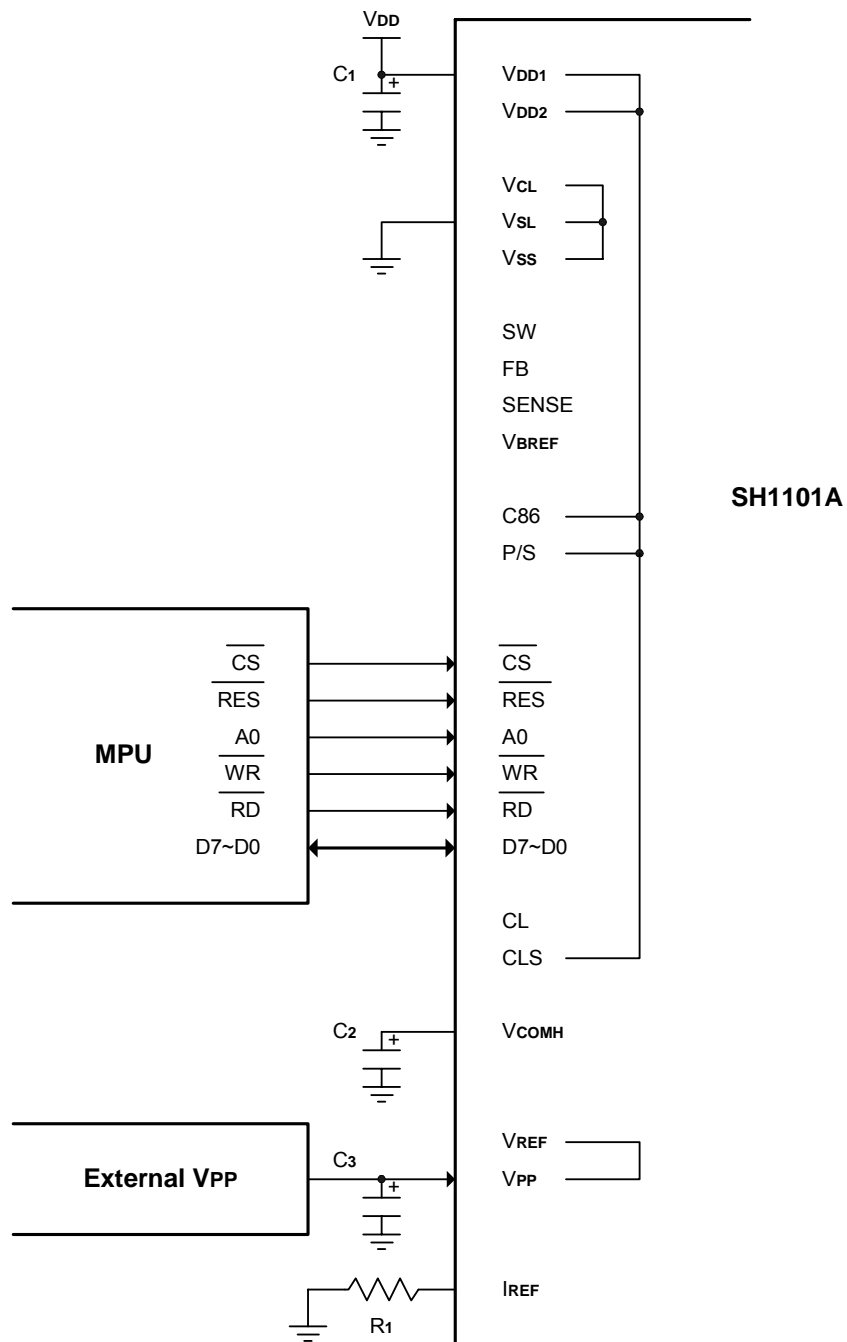


Figure. 8

Note:

C1 - C3: 4.7μF.

R1: about 910kΩ,  $R1 = (\text{Voltage at IREF} - V_{SS})/I_{REF}$



2. 6800 Series Interface: (Internal oscillator, Built-in DC-DC)

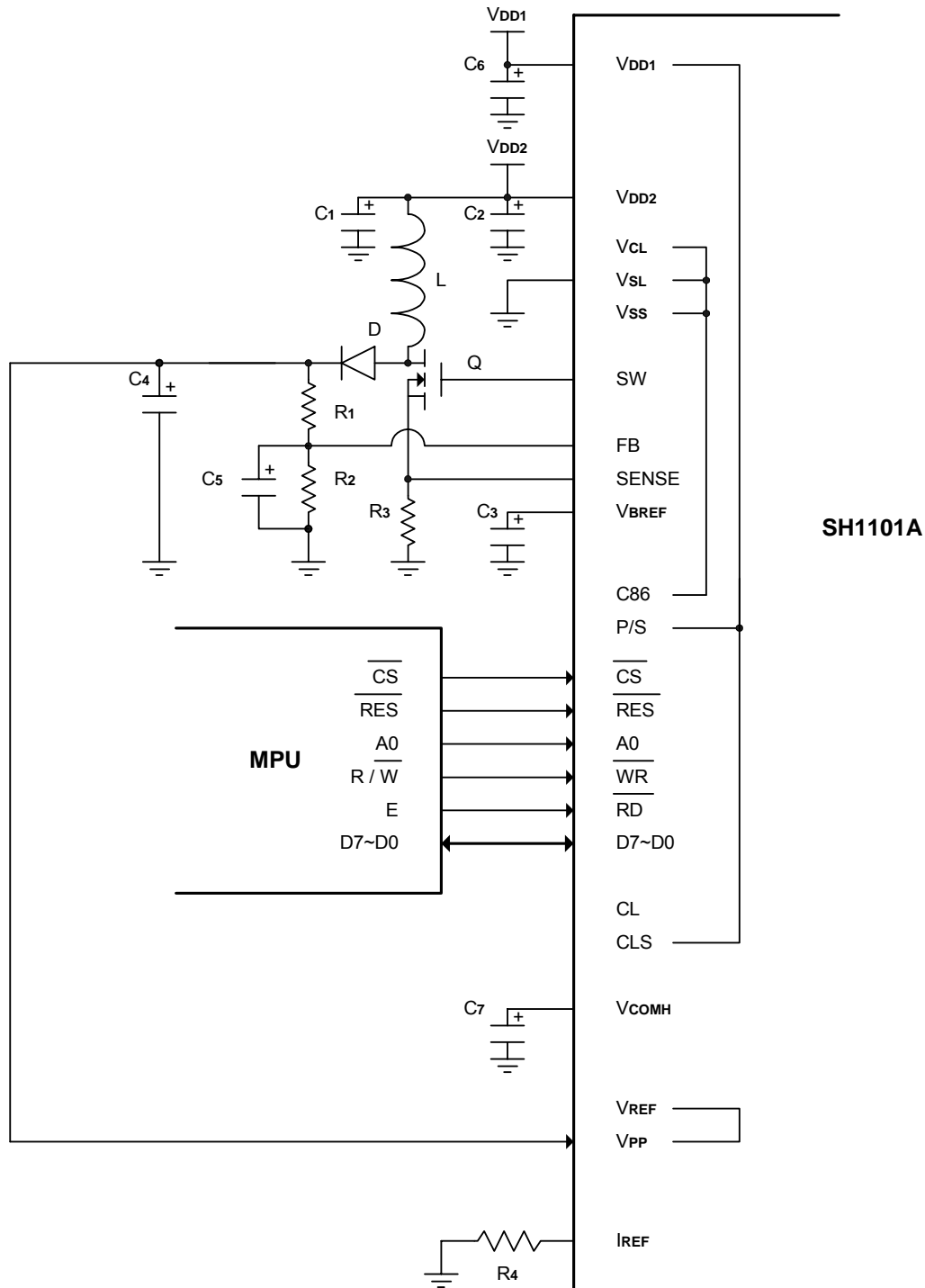


Figure. 9

Note:

L, D, Q, R1, R2, R3, C1 - C6: Please refer to following description of DC-DC module.

C6, C7: 4.7μF

R3: about 910kΩ, R4 = (Voltage at IREF - Vss)/IREF



3. Serial Interface: (External oscillator, External VPP)

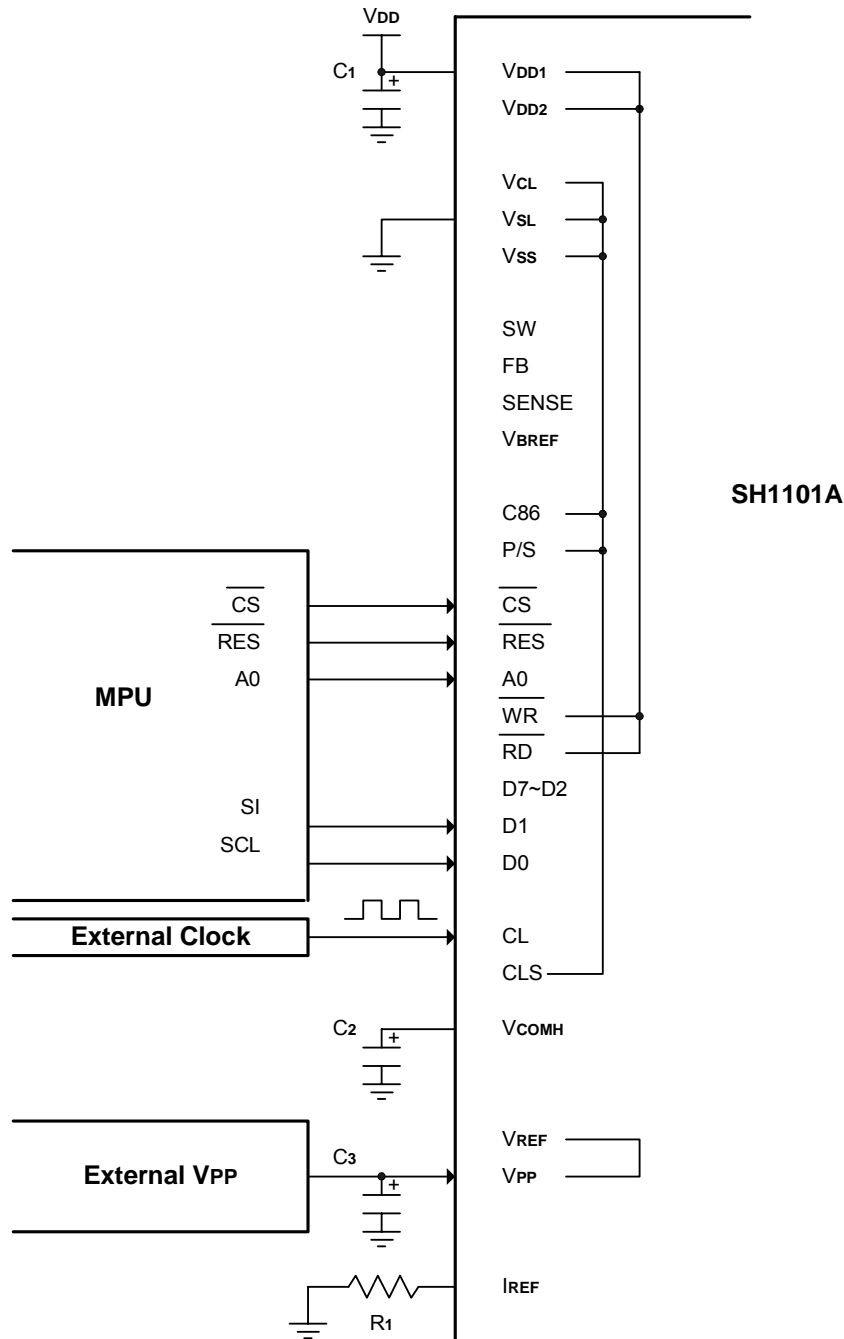


Figure. 10

Note:

C1 - C3: 4.7μF

R1: about 910kΩ,  $R1 = (\text{Voltage at IREF} - V_{ss})/I_{REF}$



**DC-DC:**

Below application circuit is an example for the input voltage of 3V  $V_{DD2}$  to generate  $V_{PP}$  of about 12V@10mA-25mA application.

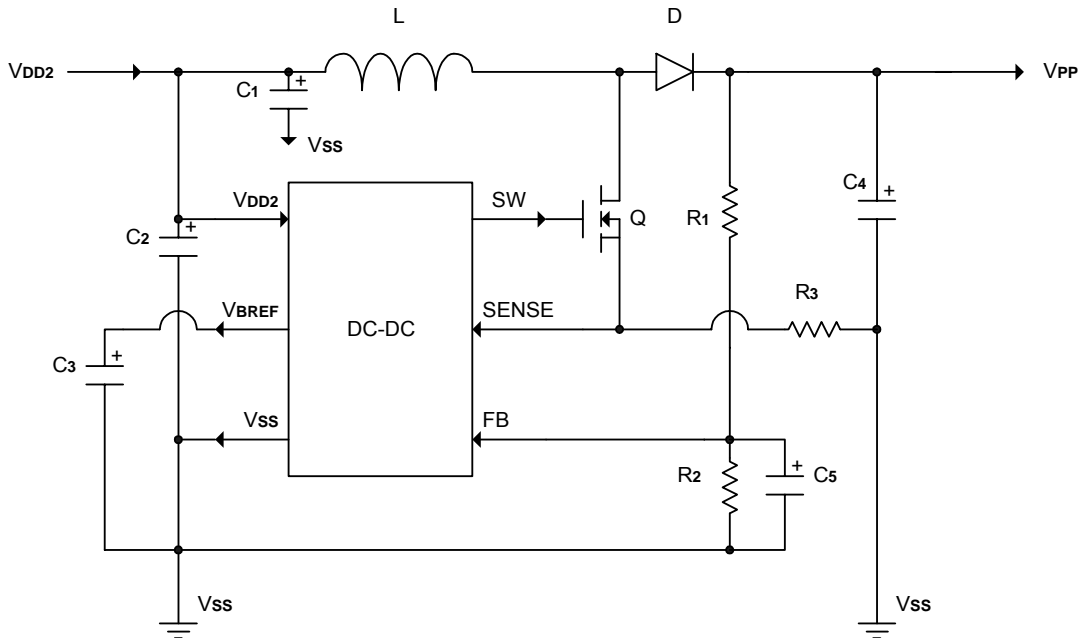
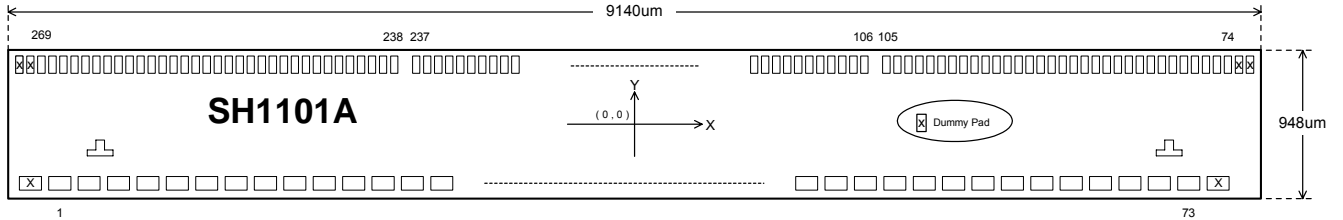


Figure. 11

Symbol	Value	Recommendation
L	10 $\mu$ H	LQH3C100K24
D	SCHOTTKY DIODE	20V@0.5A, MBR0520
Q	MOSFET	N-FET with low $R_{DS(on)}$ and low $V_{TH}$ , MGSF1N02LT1
R1	930k $\Omega$	1%, 1/8W
R2	110k $\Omega$	1%, 1/8W
R3	0.12 $\Omega$	1%, 1/2W
C1	1 - 10 $\mu$ F	Low ESR/6.3V
C2	0.1 - 1 $\mu$ F	Ceramic/16V
C3	1 $\mu$ F	Ceramic/16V
C4	6.8 $\mu$ F	Low ESR/16V
C5	1000pF	Ceramic/16V



**Bonding Diagram**



**Pad Location (Total: 269 pads)**

unit:  $\mu\text{m}$

Pad No.	Designation	X	Y	Pad No.	Designation	X	Y
1	VCL	-4359.45	-414.15	31	VDD1	-759.45	-414.15
2	VCL	-4239.45	-414.15	32	VSS	-639.45	-414.15
3	VCL	-4119.45	-414.15	33	C86	-519.45	-414.15
4	VSL	-3999.45	-414.15	34	VDD1	-399.45	-414.15
5	VSL	-3879.45	-414.15	35	P/S	-279.45	-414.15
6	VSL	-3759.45	-414.15	36	VSS	-159.45	-414.15
7	VSS	-3639.45	-414.15	37	CL	-39.45	-414.15
8	VSS	-3519.45	-414.15	38	$\overline{\text{CS}}$	80.55	-414.15
9	VSS	-3399.45	-414.15	39	$\overline{\text{RES}}$	200.55	-414.15
10	VSS	-3279.45	-414.15	40	A0	320.55	-414.15
11	VSS	-3159.45	-414.15	41	$\overline{\text{WR}}$	440.55	-414.15
12	VSS	-3039.45	-414.15	42	VSS	560.55	-414.15
13	VSS	-2919.45	-414.15	43	$\overline{\text{RD}}$	680.55	-414.15
14	SW	-2799.45	-414.15	44	VDD1	800.55	-414.15
15	SW	-2679.45	-414.15	45	VCOMH	920.55	-414.15
16	SW	-2559.45	-414.15	46	VCOMH	1040.55	-414.15
17	VDD2	-2439.45	-414.15	47	VCOMH	1160.55	-414.15
18	VDD2	-2319.45	-414.15	48	VCOMH	1280.55	-414.15
19	VDD2	-2199.45	-414.15	49	VPP	1400.55	-414.15
20	VDD2	-2079.45	-414.15	50	VPP	1520.55	-414.15
21	VSS	-1959.45	-414.15	51	VPP	1640.55	-414.15
22	FB	-1839.45	-414.15	52	VPP	1760.55	-414.15
23	SENSE	-1719.45	-414.15	53	VPP	1880.55	-414.15
24	VBREF	-1599.45	-414.15	54	D0	2000.55	-414.15
25	TEST1	-1479.45	-414.15	55	D1	2120.55	-414.15
26	TEST3	-1359.45	-414.15	56	D2	2240.55	-414.15
27	TEST2	-1239.45	-414.15	57	D3	2360.55	-414.15
28	VDD1	-1119.45	-414.15	58	D4	2480.55	-414.15
29	VDD1	-999.45	-414.15	59	D5	2600.55	-414.15
30	VDD1	-879.45	-414.15	60	D6	2720.55	-414.15



Pad Location (continued)

Pad No.	Designation	X	Y	Pad No.	Designation	X	Y
61	D7	2840.55	-414.15	101	COM8	3217.95	406.6
62	VDD1	2960.55	-414.15	102	COM6	3172.95	406.6
63	CLS	3080.55	-414.15	103	COM4	3127.95	406.6
64	VSS	3200.55	-414.15	104	COM2	3082.95	406.6
65	IREF	3320.55	-414.15	105	COM0	3037.95	406.6
66	VPP	3440.55	-414.15	106	SEG0	2947.95	406.6
67	VCOMH	3560.55	-414.15	107	SEG1	2902.95	406.6
68	VCOMH	3680.55	-414.15	108	SEG2	2857.95	406.6
69	VCOMH	3800.55	-414.15	109	SEG3	2812.95	406.6
70	VREF	3920.55	-414.15	110	SEG4	2767.95	406.6
71	VPP	4040.55	-414.15	111	SEG5	2722.95	406.6
72	VPP	4160.55	-414.15	112	SEG6	2677.95	406.6
73	VPP	4280.55	-414.15	113	SEG7	2632.95	406.6
74	COM62	4432.95	406.6	114	SEG8	2587.95	406.6
75	COM60	4387.95	406.6	115	SEG9	2542.95	406.6
76	COM58	4342.95	406.6	116	SEG10	2497.95	406.6
77	COM56	4297.95	406.6	117	SEG11	2452.95	406.6
78	COM54	4252.95	406.6	118	SEG12	2407.95	406.6
79	COM52	4207.95	406.6	119	SEG13	2362.95	406.6
80	COM50	4162.95	406.6	120	SEG14	2317.95	406.6
81	COM48	4117.95	406.6	121	SEG15	2272.95	406.6
82	COM46	4072.95	406.6	122	SEG16	2227.95	406.6
83	COM44	4027.95	406.6	123	SEG17	2182.95	406.6
84	COM42	3982.95	406.6	124	SEG18	2137.95	406.6
85	COM40	3937.95	406.6	125	SEG19	2092.95	406.6
86	COM38	3892.95	406.6	126	SEG20	2047.95	406.6
87	COM36	3847.95	406.6	127	SEG21	2002.95	406.6
88	COM34	3802.95	406.6	128	SEG22	1957.95	406.6
89	COM32	3757.95	406.6	129	SEG23	1912.95	406.6
90	COM30	3712.95	406.6	130	SEG24	1867.95	406.6
91	COM28	3667.95	406.6	131	SEG25	1822.95	406.6
92	COM26	3622.95	406.6	132	SEG26	1777.95	406.6
93	COM24	3577.95	406.6	133	SEG27	1732.95	406.6
94	COM22	3532.95	406.6	134	SEG28	1687.95	406.6
95	COM20	3487.95	406.6	135	SEG29	1642.95	406.6
96	COM18	3442.95	406.6	136	SEG30	1597.95	406.6
97	COM16	3397.95	406.6	137	SEG31	1552.95	406.6
98	COM14	3352.95	406.6	139	SEG32	1507.95	406.6
99	COM12	3307.95	406.6	139	SEG33	1462.95	406.6
100	COM10	3262.95	406.6	140	SEG34	1417.95	406.6





Pad Location (continued)

Pad No.	Designation	X	Y	Pad No.	Designation	X	Y
141	SEG35	1372.95	406.6	181	SEG75	-427.05	406.6
142	SEG36	1327.95	406.6	182	SEG76	-472.05	406.6
143	SEG37	1282.95	406.6	183	SEG77	-517.05	406.6
144	SEG38	1237.95	406.6	184	SEG78	-562.05	406.6
145	SEG39	1192.95	406.6	185	SEG79	-607.05	406.6
146	SEG40	1147.95	406.6	186	SEG80	-652.05	406.6
147	SEG41	1102.95	406.6	187	SEG81	-697.05	406.6
148	SEG42	1057.95	406.6	188	SEG82	-742.05	406.6
149	SEG43	1012.95	406.6	189	SEG83	-787.05	406.6
150	SEG44	967.95	406.6	190	SEG84	-832.05	406.6
151	SEG45	922.95	406.6	191	SEG85	-877.05	406.6
152	SEG46	877.95	406.6	192	SEG86	-922.05	406.6
153	SEG47	832.95	406.6	193	SEG87	-967.05	406.6
154	SEG48	787.95	406.6	194	SEG88	-1012.05	406.6
155	SEG49	742.95	406.6	195	SEG89	-1057.05	406.6
156	SEG50	697.95	406.6	196	SEG90	-1102.05	406.6
157	SEG51	652.95	406.6	197	SEG91	-1147.05	406.6
158	SEG52	607.95	406.6	198	SEG92	-1192.05	406.6
159	SEG53	562.95	406.6	199	SEG93	-1237.05	406.6
160	SEG54	517.95	406.6	200	SEG94	-1282.05	406.6
161	SEG55	472.95	406.6	201	SEG95	-1327.05	406.6
162	SEG56	427.95	406.6	202	SEG96	-1372.05	406.6
163	SEG57	382.95	406.6	203	SEG97	-1417.05	406.6
164	SEG58	337.95	406.6	204	SEG98	-1462.05	406.6
165	SEG59	292.95	406.6	205	SEG99	-1507.05	406.6
166	SEG60	247.95	406.6	206	SEG100	-1552.05	406.6
167	SEG61	202.95	406.6	207	SEG101	-1597.05	406.6
168	SEG62	157.95	406.6	208	SEG102	-1642.05	406.6
169	SEG63	112.95	406.6	209	SEG103	-1687.05	406.6
170	SEG64	67.95	406.6	210	SEG104	-1732.05	406.6
171	SEG65	22.95	406.6	211	SEG105	-1777.05	406.6
172	SEG66	-22.05	406.6	212	SEG106	-1822.05	406.6
173	SEG67	-67.05	406.6	213	SEG107	-1867.05	406.6
174	SEG68	-112.05	406.6	214	SEG108	-1912.05	406.6
175	SEG69	-157.05	406.6	215	SEG109	-1957.05	406.6
176	SEG70	-202.05	406.6	216	SEG110	-2002.05	406.6
177	SEG71	-247.05	406.6	217	SEG111	-2047.05	406.6
178	SEG72	-292.05	406.6	218	SEG112	-2092.05	406.6
179	SEG73	-337.05	406.6	219	SEG113	-2137.05	406.6
180	SEG74	-382.05	406.6	220	SEG114	-2182.05	406.6



Pad Location (continued)

Pad No.	Designation	X	Y	Pad No.	Designation	X	Y
221	SEG115	-2227.05	406.6	246	COM17	-3397.05	406.6
222	SEG116	-2272.05	406.6	247	COM19	-3442.05	406.6
223	SEG117	-2317.05	406.6	248	COM21	-3487.05	406.6
224	SEG118	-2362.05	406.6	249	COM23	-3532.05	406.6
225	SEG119	-2407.05	406.6	250	COM25	-3577.05	406.6
226	SEG120	-2452.05	406.6	251	COM27	-3622.05	406.6
227	SEG121	-2497.05	406.6	252	COM29	-3667.05	406.6
228	SEG122	-2542.05	406.6	253	COM31	-3712.05	406.6
229	SEG123	-2587.05	406.6	254	COM33	-3757.05	406.6
230	SEG124	-2632.05	406.6	255	COM35	-3802.05	406.6
231	SEG125	-2677.05	406.6	256	COM37	-3847.05	406.6
232	SEG126	-2722.05	406.6	257	COM39	-3892.05	406.6
233	SEG127	-2767.05	406.6	258	COM41	-3937.05	406.6
234	SEG128	-2812.05	406.6	259	COM43	-3982.05	406.6
235	SEG129	-2857.05	406.6	260	COM45	-4027.05	406.6
236	SEG130	-2902.05	406.6	261	COM47	-4072.05	406.6
237	SEG131	-2947.05	406.6	262	COM49	-4117.05	406.6
238	COM1	-3037.05	406.6	263	COM51	-4162.05	406.6
239	COM3	-3082.05	406.6	264	COM53	-4207.05	406.6
240	COM5	-3127.05	406.6	265	COM55	-4252.05	406.6
241	COM7	-3172.05	406.6	266	COM57	-4297.05	406.6
242	COM9	-3217.05	406.6	267	COM59	-4342.05	406.6
243	COM11	-3262.05	406.6	268	COM61	-4387.05	406.6
244	COM13	-3307.05	406.6	269	COM63	-4432.05	406.6
245	COM15	-3352.05	406.6				



**SH1101A**

**Dummy Pad Location (Total: 6 pads)**

unit:  $\mu\text{m}$

NO	X	Y	NO	X	Y	NO	X	Y
0	-4479.45	-414.15	2	4522.95	406.6	4	-4477.05	406.6
1	4400.55	-414.15	3	4477.95	406.6	5	-4522.05	406.6

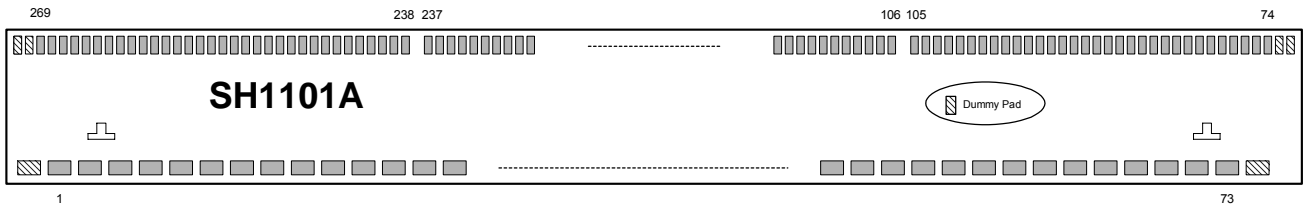
**Alignment Mark Location**

unit:  $\mu\text{m}$

NO	X	Y
L	-4195	-344
R	4195	-344



Package Information



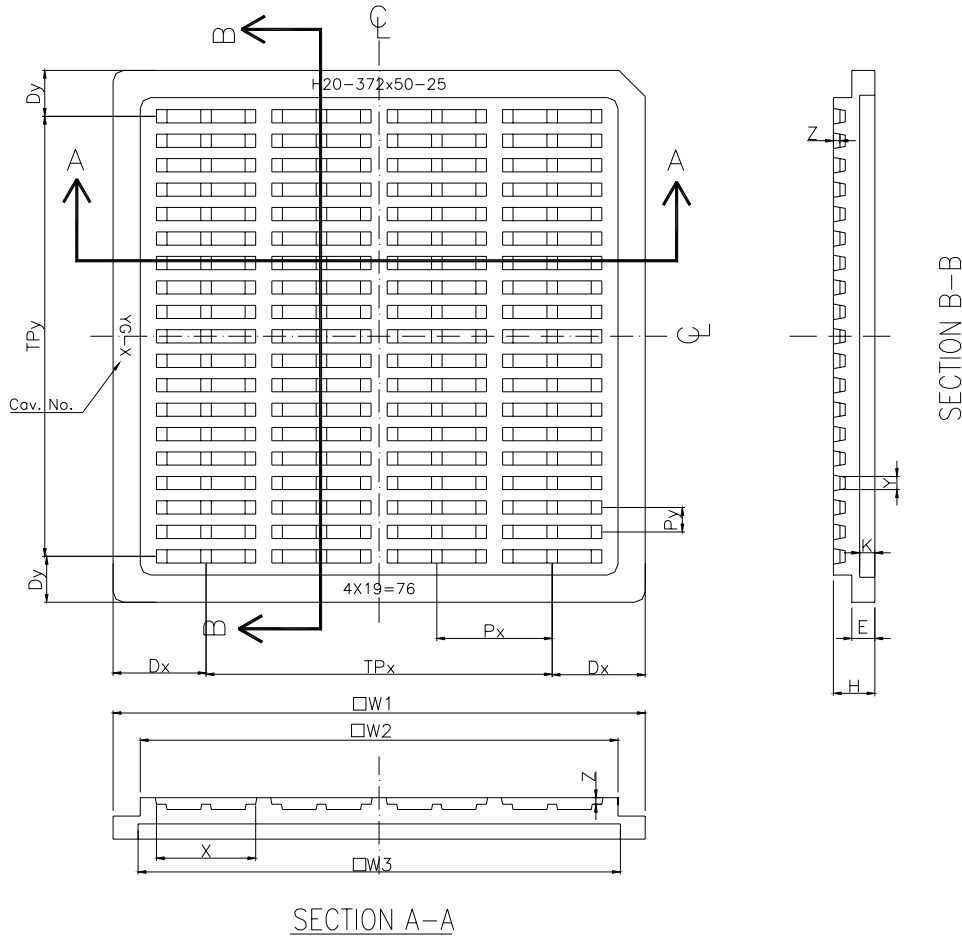
Chip Outline Dimensions

unit:  $\mu\text{m}$

Item	Pad No.	Size	
		X	Y
Chip boundary	-	9140	948
Chip height	All pads	482.6	
Bump size	1~73	90	55
	74~269	30	70
	Dummy 0, Dummy 1	90	55
	Dummy 2~ Dummy 5	30	70
Pad pitch	Dummy 0, 1~73, Dummy 1	120	
	Dummy 2~Dummy3, 74~105	45	
	106~237		
	238~269, Dummy 4~Dummy 5		
	105~106	90	
237~238			
Bump height	All pads	15	



Tray Information

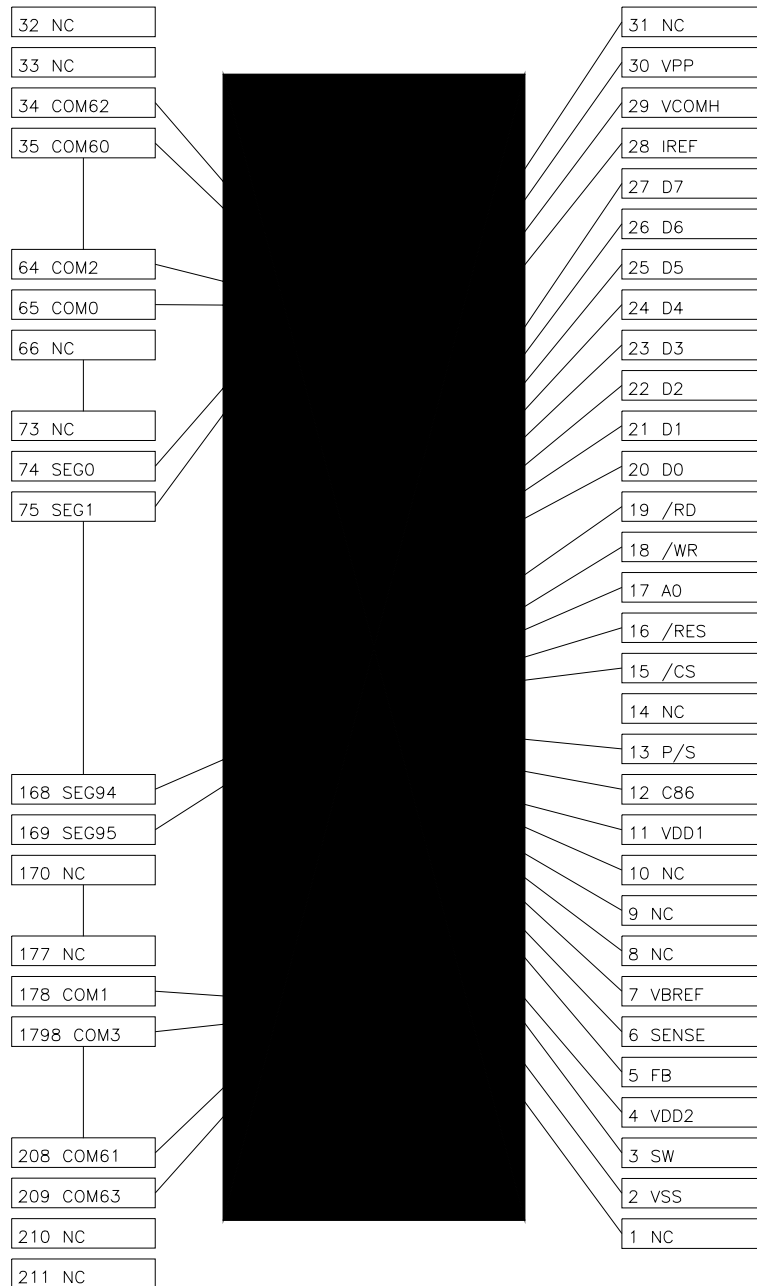


SECTION A-A

	Spec
	mm (mil)
W1	50.70±0.05 (1996)
W2	45.50±0.10 (1791)
W3	45.95±0.10 (1809)
H	3.95±0.05 (156)
E	2.20±0.05 (87)
K	1.45±0.10 (57)
Dx	8.87±0.05 (349)
TPx	32.97±0.10 (1298)
Dy	4.38±0.05 (172)
TPy	41.94±0.10 (1651)
Px	10.99±0.05 (433)
Py	2.33±0.05 (92)
X	9.45±0.05 (372)
Y	1.26±0.05 (50)
Z	0.63±0.05 (25)
N	76(pocket number)



SH1101A-TCP03 TCP Pin Layout



(Copper Side View)



SH1101A-TCP03 TCP Pin Assignment (Total: 211 pins)

Pin No.	Designation	Pin No.	Designation	Pin No.	Designation	Pin No.	Designation
1	NC	41	COM48	81	SEG7	121	SEG47
2	Vss	42	COM46	82	SEG8	122	SEG48
3	SW	43	COM44	83	SEG9	123	SEG49
4	VDD2	44	COM42	84	SEG10	124	SEG50
5	FB	45	COM40	85	SEG11	125	SEG51
6	SENSE	46	COM38	86	SEG12	126	SEG52
7	VBREF	47	COM36	87	SEG13	127	SEG53
8	NC	48	COM34	88	SEG14	128	SEG54
9	NC	49	COM32	89	SEG15	129	SEG55
10	NC	50	COM30	90	SEG16	130	SEG56
11	VDD1	51	COM28	91	SEG17	131	SEG57
12	C86	52	COM26	92	SEG18	132	SEG58
13	P/S	53	COM24	93	SEG19	133	SEG59
14	NC	54	COM22	94	SEG20	134	SEG60
15	$\overline{CS}$	55	COM20	95	SEG21	135	SEG61
16	$\overline{RES}$	56	COM18	96	SEG22	136	SEG62
17	A0	57	COM16	97	SEG23	137	SEG63
18	$\overline{WR}$	58	COM14	98	SEG24	139	SEG64
19	$\overline{RD}$	59	COM12	99	SEG25	139	SEG65
20	D0	60	COM10	100	SEG26	140	SEG66
21	D1	61	COM8	101	SEG27	141	SEG67
22	D2	62	COM6	102	SEG28	142	SEG68
23	D3	63	COM4	103	SEG29	143	SEG69
24	D4	64	COM2	104	SEG30	144	SEG70
25	D5	65	COM0	105	SEG31	145	SEG71
26	D6	66	NC	106	SEG32	146	SEG72
27	D7	67	NC	107	SEG33	147	SEG73
28	IREF	68	NC	108	SEG34	148	SEG74
29	VCOMH	69	NC	109	SEG35	149	SEG75
30	VPP	70	NC	110	SEG36	150	SEG76
31	NC	71	NC	111	SEG37	151	SEG77
32	NC	72	NC	112	SEG38	152	SEG78
33	NC	73	NC	113	SEG39	153	SEG79
34	COM62	74	SEG0	114	SEG40	154	SEG80
35	COM60	75	SEG1	115	SEG41	155	SEG81
36	COM58	76	SEG2	116	SEG42	156	SEG82
37	COM56	77	SEG3	117	SEG43	157	SEG83
38	COM54	78	SEG4	118	SEG44	158	SEG84
39	COM52	79	SEG5	119	SEG45	159	SEG85
40	COM50	80	SEG6	120	SEG46	160	SEG86



SH1101A-TCP03 TCP Pin Assignment (continued)

Pin No.	Designation	Pin No.	Designation	Pin No.	Designation	Pin No.	Designation
161	SEG87	176	NC	191	COM27	206	COM57
162	SEG88	177	NC	192	COM29	207	COM59
163	SEG89	178	COM1	193	COM31	208	COM61
164	SEG90	179	COM3	194	COM33	209	COM63
165	SEG91	180	COM5	195	COM35	210	NC
166	SEG92	181	COM7	196	COM37	211	NC
167	SEG93	182	COM9	197	COM39		
168	SEG94	183	COM11	198	COM41		
169	SEG95	184	COM13	199	COM43		
170	NC	185	COM15	200	COM45		
171	NC	186	COM17	201	COM47		
172	NC	187	COM19	202	COM49		
173	NC	188	COM21	203	COM51		
174	NC	189	COM23	204	COM53		
175	NC	190	COM25	205	COM55		

**Note:**

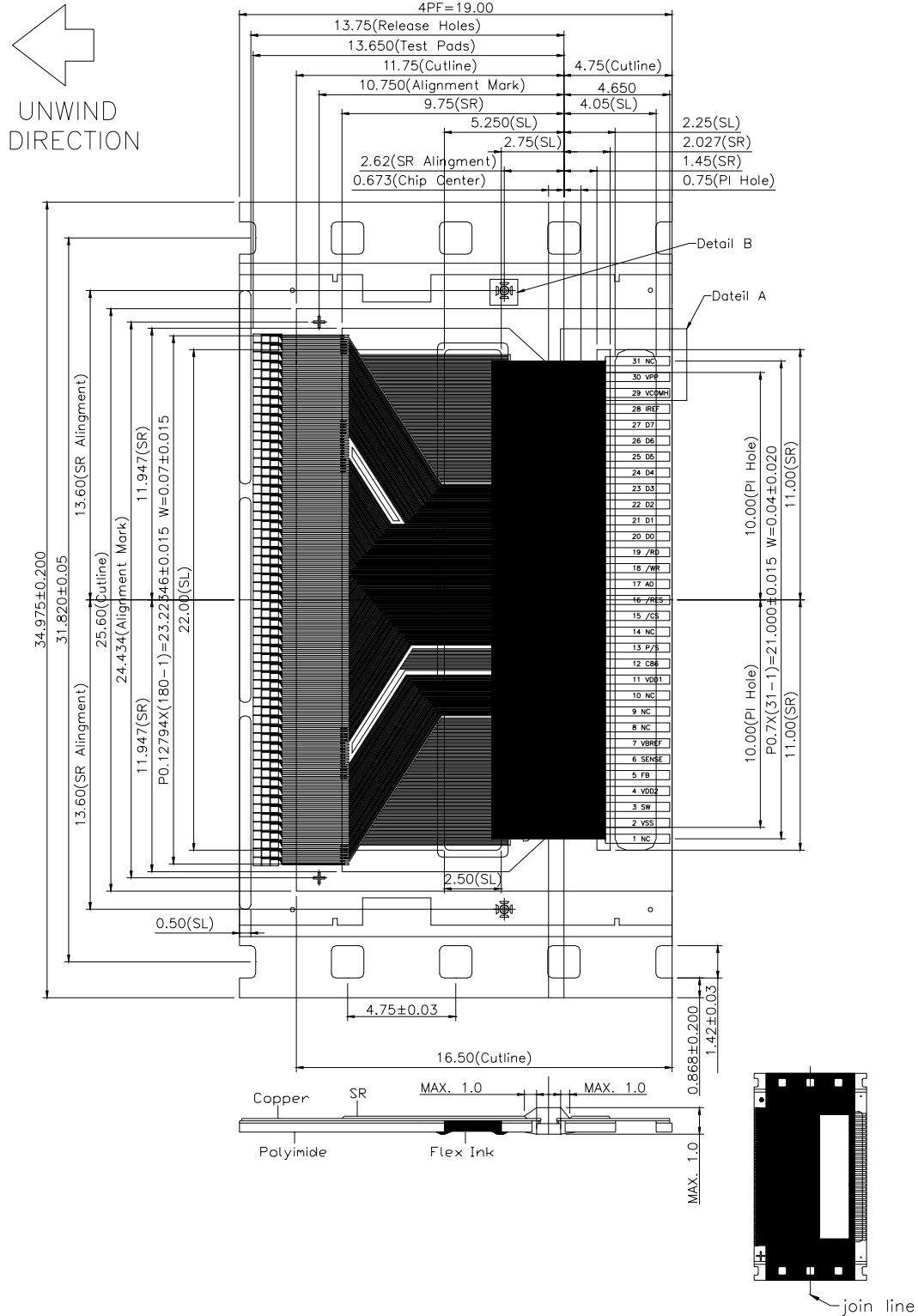
Following is the details of pad connection in SH1101A-TCP03 (TCP Form).

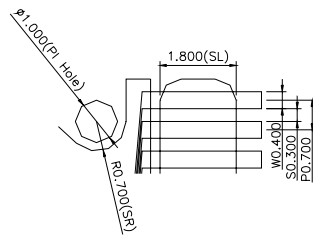
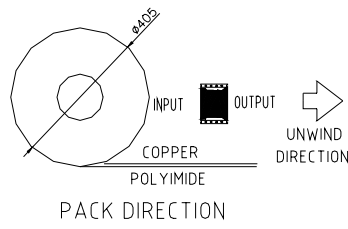
- “CLS” pad connects to “VDD1” pad, Internal oscillator circuit is enabled.
- “VREF” pad connects to “VPP” pad.
- “VCL” & “VSL” pad connects to “VSS” pad.
- “C86” & “P/S” pad options can be selected by user. So SH1101A-TCP03 (TCP Form) supports 8-bit 6800-series parallel interface, 8-bit 8080-series parallel interface or serial peripheral interface.
- SH1101A-TCP03 (TCP Form) supports internal DC-DC converter function.



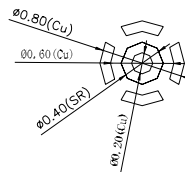


External View of SH1101A-TCP03 TCP Pins

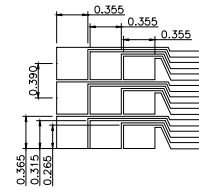




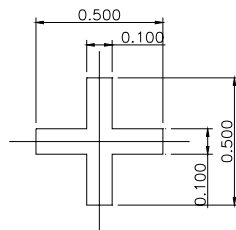
Detail A  
Scale 2:1



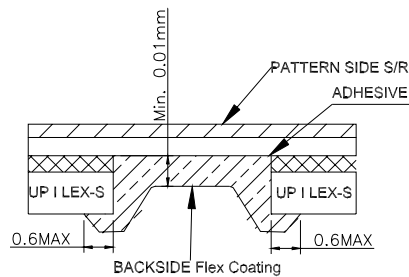
Detail B  
Scale 5:1



Detail of Test Pads  
Scale 5:1



Detail of Alignment Mark  
Scale 10:1



NOTES:

1. All SR Dimension Tolerance  $\pm 0.200$ mm if not specified
2. All SL Dimension Tolerance  $\pm 0.05$ mm if not specified
3. Corner radiuses unless otherwise specified is  $\pm 0.20$ mm
4. PKG Reel Size :  $\phi 4.05$ mm
5. Input IL total pitch from left 2nd to right 2nd
6. Output IL total pitch from left 2nd to right 2nd
7. IL Pitch=45um ; Min Pitch=45um/IL/Tracerl

**Cautions Concerning Storage:**

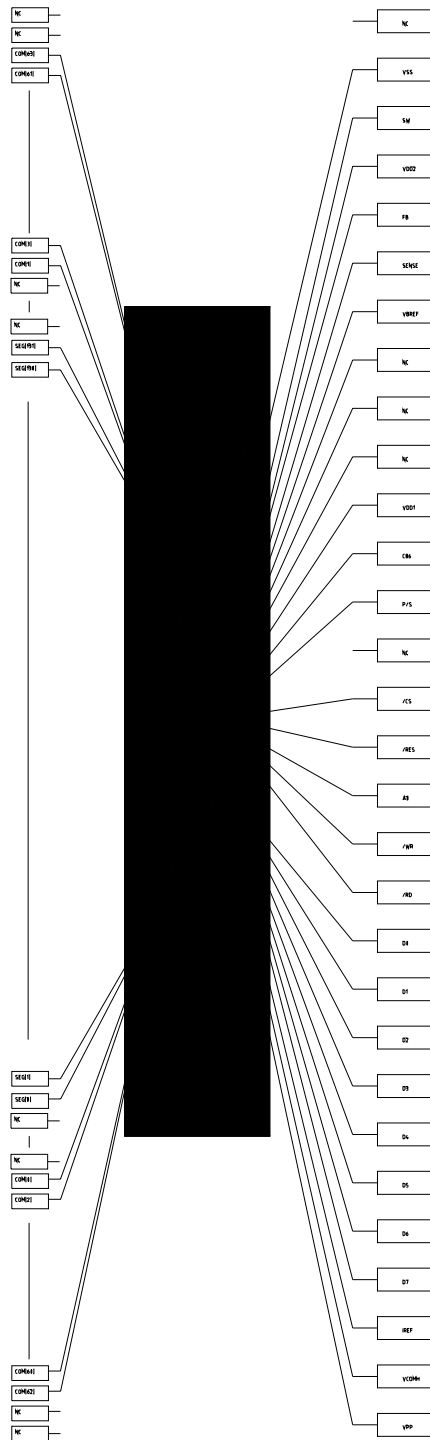
1. When storing the product, it is recommended that it be left in its shipping package.  
After the seal of the packing bag has been broken, store the products in a nitrogen atmosphere.
2. Storage conditions:

Storage state	Storage conditions
unopened ( <b>less than 90 days</b> )	Temperature: 5 to 30 ; humidity: 80%RH or less.
After seal of broken ( <b>less than 30 days</b> )	Room temperature, dry nitrogen atmosphere

3. Don't store in a location exposed to corrosive gas or excessive dust.
4. Don't store in a location exposed to direct sunlight or subject to sharp changes in temperature.
5. Don't store the product such that it is subjected to an excessive load weight, such as by stacking.
6. Deterioration of the plating may occur after long-term storage, so special care is required.  
It is recommended that the products be inspected before use.



SH1101A-TCP06 TCP Pin Layout



(Copper Side View)



SH1101A-TCP06 TCP Pin Assignment (Total: 249 pads)

Pin No.	Designation	Pin No.	Designation	Pin No.	Designation	Pin No.	Designation
1	NC	41	COM49	81	SEG123	121	SEG83
2	VPP	42	COM47	82	SEG122	122	SEG82
3	VCOMH	43	COM45	83	SEG121	123	SEG81
4	IREF	44	COM43	84	SEG120	124	SEG80
5	D7	45	COM41	85	SEG119	125	SEG79
6	D6	46	COM39	86	SEG118	126	SEG78
7	D5	47	COM37	87	SEG117	127	SEG77
8	D4	48	COM35	88	SEG116	128	SEG76
9	D3	49	COM33	89	SEG115	129	SEG75
10	D2	50	COM31	90	SEG114	130	SEG74
11	D1	51	COM29	91	SEG113	131	SEG73
12	D0	52	COM27	92	SEG112	132	SEG72
13	$\overline{RD}$	53	COM25	93	SEG111	133	SEG71
14	$\overline{WR}$	54	COM23	94	SEG110	134	SEG70
15	A0	55	COM21	95	SEG109	135	SEG69
16	$\overline{RES}$	56	COM19	96	SEG108	136	SEG68
17	$\overline{CS}$	57	COM17	97	SEG107	137	SEG67
18	NC	58	COM15	98	SEG106	139	SEG66
19	P/S	59	COM13	99	SEG105	139	SEG65
20	C86	60	COM11	100	SEG104	140	SEG64
21	VDD1	61	COM9	101	SEG103	141	SEG63
22	NC	62	COM7	102	SEG102	142	SEG62
23	NC	63	COM5	103	SEG101	143	SEG61
24	NC	64	COM3	104	SEG100	144	SEG60
25	VBREF	65	COM1	105	SEG99	145	SEG59
26	SENSE	66	NC	106	SEG98	146	SEG58
27	FB	67	NC	107	SEG97	147	SEG57
28	VDD2	68	NC	108	SEG96	148	SEG56
29	SW	69	NC	109	SEG95	149	SEG55
30	VSS	70	NC	110	SEG94	150	SEG54
31	NC	71	NC	111	SEG93	151	SEG53
32	NC	72	NC	112	SEG92	152	SEG52
33	NC	73	SEG131	113	SEG91	153	SEG51
34	COM63	74	SEG130	114	SEG90	154	SEG50
35	COM61	75	SEG129	115	SEG89	155	SEG49
36	COM59	76	SEG128	116	SEG88	156	SEG48
37	COM57	77	SEG127	117	SEG87	157	SEG47
38	COM55	78	SEG126	118	SEG86	158	SEG46
39	COM53	79	SEG125	119	SEG85	159	SEG45
40	COM51	80	SEG124	120	SEG84	160	SEG44



TCP Pin Assignment (continued)

Pin No.	Designation	Pin No.	Designation	Pin No.	Designation	Pin No.	Designation
161	SEG43	184	SEG20	207	NC	230	COM28
162	SEG42	185	SEG19	208	NC	231	COM30
163	SEG41	186	SEG18	209	NC	232	COM32
164	SEG40	187	SEG17	210	NC	233	COM34
165	SEG39	188	SEG16	211	NC	234	COM36
166	SEG38	189	SEG15	212	NC	235	COM38
167	SEG37	190	SEG14	213	NC	236	COM40
168	SEG36	191	SEG13	214	NC	237	COM42
169	SEG35	192	SEG12	215	NC	238	COM44
170	SEG34	193	SEG11	216	COM0	239	COM46
171	SEG33	194	SEG10	217	COM2	240	COM48
172	SEG32	195	SEG9	218	COM4	241	COM50
173	SEG31	196	SEG8	219	COM6	242	COM52
174	SEG30	197	SEG7	220	COM8	243	COM54
175	SEG29	198	SEG6	221	COM10	244	COM56
176	SEG28	199	SEG5	222	COM12	245	COM58
177	SEG27	200	SEG4	223	COM14	246	COM60
178	SEG26	201	SEG3	224	COM16	247	COM62
179	SEG25	202	SEG2	225	COM18	248	NC
180	SEG24	203	SEG1	226	COM20	249	NC
181	SEG23	204	SEG0	227	COM22		
182	SEG22	205	NC	228	COM24		
183	SEG21	206	NC	229	COM26		

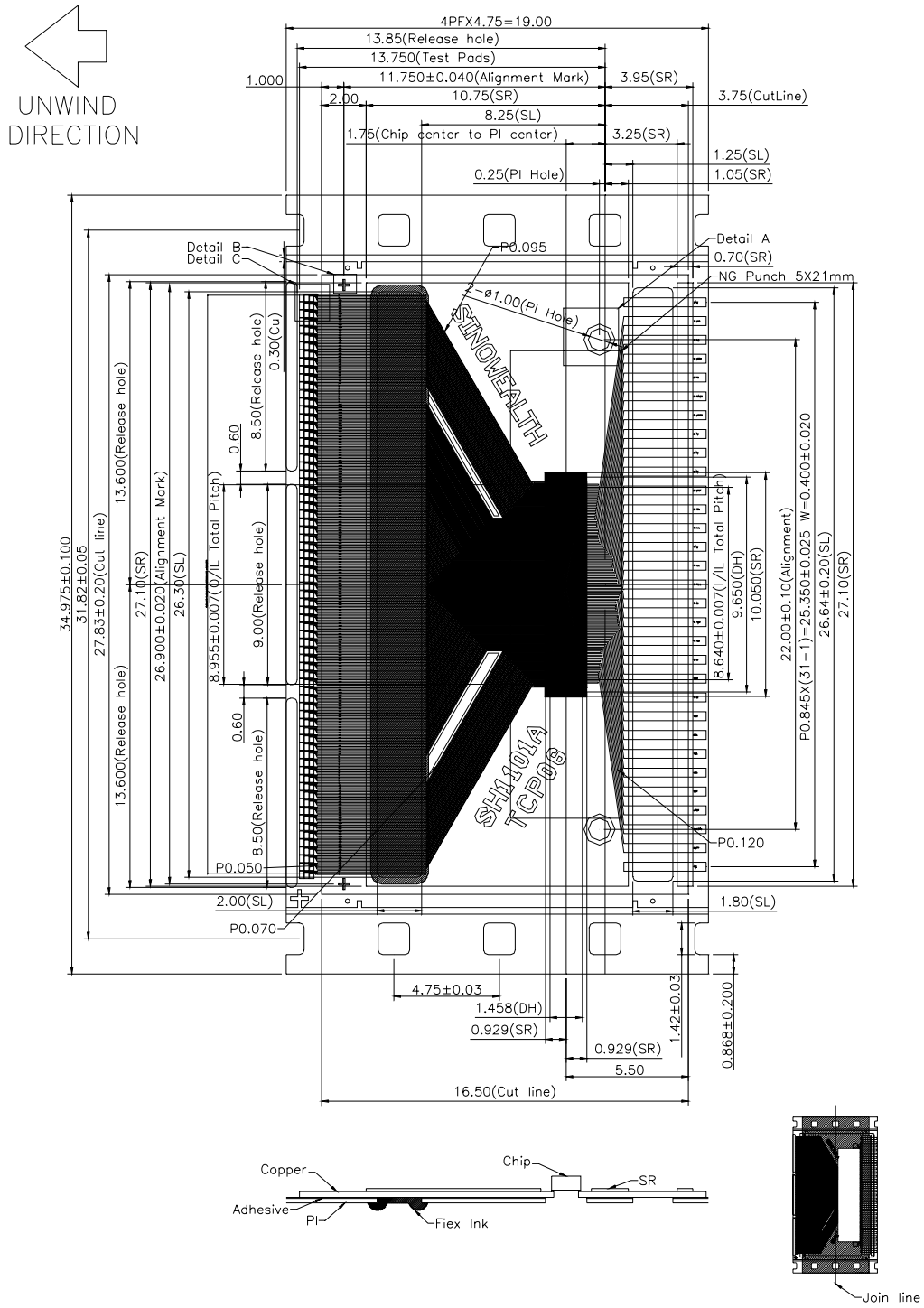
**Note:**

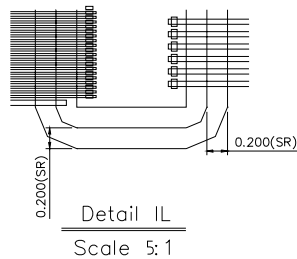
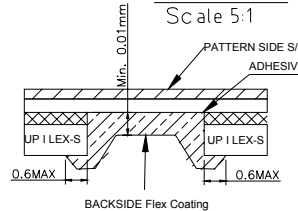
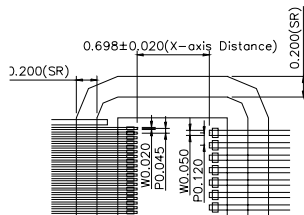
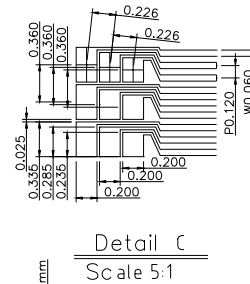
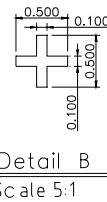
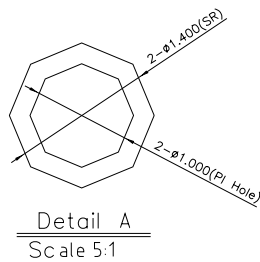
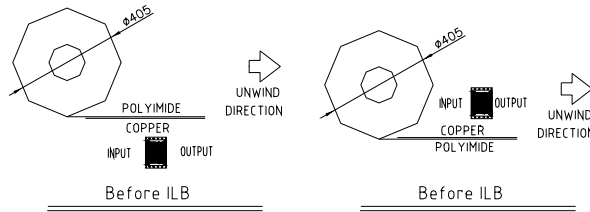
Following is the details of pad connection in SH1101A-TCP06 (TCP Form).

- “CLS” pad connects to “VDD1” pad, Internal oscillator circuit is enabled.
- “VREF” pad connects to “VPP” pad.
- “VCL” & “VSL” pad connects to “VSS” pad.
- “C86” & “P/S” pad options can be selected by user. So SH1101A-TCP06 (TCP Form) supports 8-bit 6800-series parallel interface, 8-bit 8080-series parallel interface or serial peripheral interface.
- SH1101A-TCP06 (TCP Form) supports internal DC-DC converter function.



External View of SH1101A-TCP06 TCP Pins





- NOTES:
1. All Punch Chamfer is  $R0.20mm$  if not specified
  2. All SR dimension tolerance is  $\pm 0.200mm$  if not specified
  3. PKG Reel Size  $\phi 485mm$
  4. Input IL total pitch from top 2nd to bottom 2nd
  5. Output IL total pitch from top 2nd to bottom 2nd
  6. IL total pitch in TD from right 2nd to left 2nd
  7. This Drawing is shown by Copper side over Polyimide
  8. Min Pitch=IL Pitch=45um
  9. NG Punch Size is 5X21mm

**Cautions Concerning Storage:**

1. When storing the product, it is recommended that it be left in its shipping package.  
After the seal of the packing bag has been broken, store the products in a nitrogen atmosphere.
2. Storage conditions:

Storage state	Storage conditions
unopened ( <b>less than 90 days</b> )	Temperature: 5 to 30 ; humidity: 80%RH or less.
After seal of broken ( <b>less than 30 days</b> )	Room temperature, dry nitrogen atmosphere

3. Don't store in a location exposed to corrosive gas or excessive dust.
4. Don't store in a location exposed to direct sunlight or subject to sharp changes in temperature.
5. Don't store the product such that it is subjected to an excessive load weight, such as by stacking.
6. Deterioration of the plating may occur after long-term storage, so special care is required.  
It is recommended that the products be inspected before use.



**SH1101A**

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**Ordering Information**

<b>Part No.</b>	<b>Package</b>
SH1101A-COG01	Gold bump on chip tray
SH1101A-TCP03	TCP Form
SH1101A-TCP06	TCP Form